

DRUM TRIGGER MODULE ***DTXPRESS***

SERVICE MANUAL



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IMPORTANT NOTICE

This manual has been provided for the use of authorized Yamaha Retailers and their service personnel. It has been assumed that basic service procedures inherent to the industry, and more specifically Yamaha Products, are already known and understood by the users, and have therefore not been restated.

WARNING: Failure to follow appropriate service and safety procedures when servicing this product may result in personal injury, destruction of expensive components, and failure of the product to perform as specified. For these reasons, we advise all Yamaha product owners that all service required should be performed by an authorized Yamaha Retailer or the appointed service representative.

IMPORTANT: The presentation or sale of this manual to any individual or firm does not constitute authorization, certification or recognition of any applicable technical capabilities, or establish a principle-agent relationship of any form.

The data provided is believed to be accurate and applicable to the unit(s) indicated on the cover. The research, engineering, and service departments of Yamaha are continually striving to improve Yamaha products. Modifications are, therefore, inevitable and changes in specification are subject to change without notice or obligation to retrofit. Should any discrepancy appear to exist, please contact the distributor's Service Division.

WARNING: Static discharges can destroy expensive components. Discharge any static electricity your body may have accumulated by grounding yourself to the ground buss in the unit (heavy gauge black wires connect to this buss).

IMPORTANT: Turn the unit OFF during disassembly and part replacement. Recheck all work before you apply power to the unit.

LITHIUM BATTERY HANDLING

This product uses a lithium battery for memory back-up.

WARNING: Lithium batteries are dangerous because they can be exploded by improper handling. Observe the following precautions when handling or replacing lithium batteries.

- Leave lithium battery replacement to qualified service personnel.
- Always replace with batteries of the same type.
- When installing on the PC board by soldering, solder using the connection terminals provided on the battery cells. Never solder directly to the cells. Perform the soldering as quickly as possible.
- Never reverse the battery polarities when installing.
- Do not short the batteries.
- Do not attempt to recharge these batteries.
- Do not disassemble the batteries.
- Never heat batteries or throw them into fire.

ADVARSEL!

Lithiumbatteri-Eksplosionsfare ved fejlagtig håndtering. Udskiftning må kun ske med batteri af samme fabrikat og type. Levér det brugte batteri tilbage til leverandøren.

VARNING

Explosionsfara vid felaktigt batteribyte.

Använd samma batterityp eller en ekvivalent typ som rekommenderas av apparattillverkaren.

Kassera använt batteri enligt fabrikantens instruktion.

VAROITUS

Paristo voi räjähtää, jos se on virheellisesti asennettu.

Vaihda paristo ainoastaan laitevalmistajan suosittelemaan tyyppiin.

Hävitätä käytetty paristo valmistajan ohjeiden mukaisesti.

The following information complies with Dutch Official Gazette 1995. 45; ESSENTIALS OF ORDER ON THE COLLECTION OF BATTERIES.

- Please refer to the disassembly procedure for the removal of Back-up Battery.
- Leest u voor het verwijderen van de backup batterij deze beschrijving.

WARNING: CHEMICAL CONTENT NOTICE!

The solder used in the production of this product contains LEAD. In addition, other electrical/electronic and /or plastic (where applicable) components may also contain traces of chemicals found by the California Health and Welfare Agency (and possibly other entities) to cause cancer and/or birth defects or other reproductive harm.

DO NOT PLACE SOLDER, ELECTRICAL/ELECTRONIC OR PLASTIC COMPONENTS IN YOUR MOUTH FOR ANY REASON WHATSOEVER!

Avoid prolonged, unprotected contact between solder and your skin! When soldering, do not inhale solder fumes or expose eyes to solder/flux vapor!

If you come in contact with solder or components located inside the enclosure of this product, wash your hands before handling food.

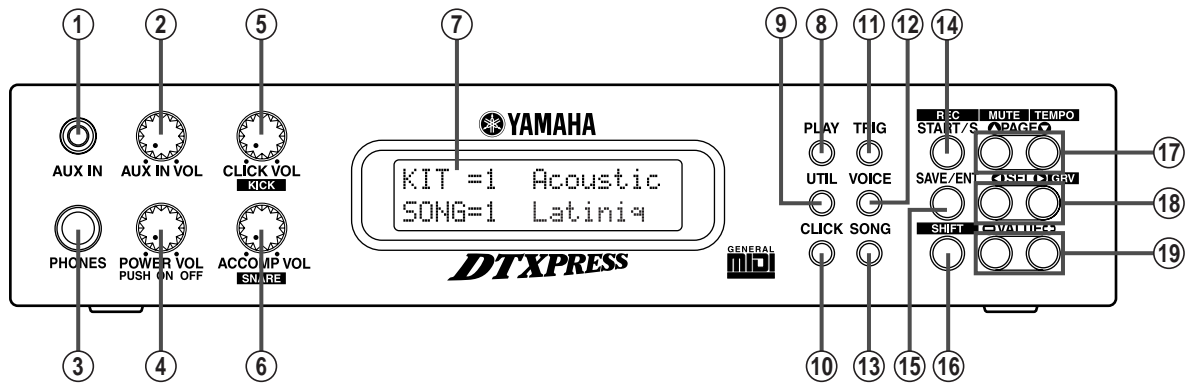
■ SPECIFICATIONS

Tone Generator	16 bit AWM2
Maximum polyphony	32
Voices	910 drum, percussion voices and effects 128 keyboard voices (GM system level 1)
Drum kits	48 Preset 32 User memory locations
Trigger setups	7 Preset 4 User memory locations
Sequencer tracks	2 (TR1, TR2)
Song control	
Main song	Start/Stop, note chase
Pad song	3 songs can be played at the same time, Trigger Control
Other Sequencer Functions	MIDI sync play, Quantize (while recording, in Song Edit job mode), Mute (rhythm mute, drum instrument mute), Groove Check
Song	95 Preset 32 User memory locations
Record modes	Real-time
Controls	
LED buttons	6 (PLAY, TRIGGER, UTILITY, VOICE, CLICK, SONG)
Buttons	9 (START/STOP, SAVE/ENTER, SHIFT, PAGEs/t, SELECT </>, VALUE-/+)
Knobs	MASTER VOLUME/POWER SW (push), ACCOMP. VOLUME, AUX VOLUME, CLICK VOLUME
Display	16 x 2 LCD display (w/Back light)
Connections	
Front Panel	Aux input (stereo mini jack) Head phone (stereo phone jack)
Rear Panel	MIDI input/output Foot controller (stereo phone jack) HOST SELECT SW TO HOST (mini DIN jack) Output L/MONO (mono phone jack) Output R (mono phone jack) Trigger Inputs 1 – 8 (stereo phone jackmL : trigger input, R : rim switch) Trigger Input 9/10 (stereo phone jackmL, R : trigger input) Trigger attenuation switch 1-6 (DIP SW)
Power supply	DC 12V/AC adaptor (PA-3B)
Power Requirement	4.8 Watt
Dimensions (W x H x D)	220 x 240 x 44 mm (8-11/16" x 9-3/16" x 1-5/16")
Weight	1.6 kg (3 lbs 8 oz)
Accessories	Owner's Manual AC adaptor (PA-3B)

* Specifications and descriptions above are for information purposes only.
Yamaha Corp. reserves the right to change or modify products or specifications at any time without prior notice.

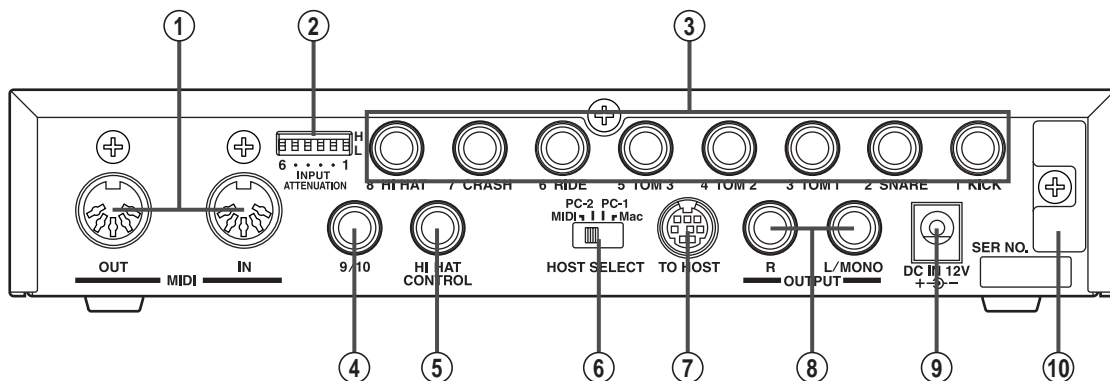
■ PANEL LAYOUT

• Rear Panel



- ① AUX IN Jack
- ② AUX IN Volume (AUX IN VOL)
- ③ Head Phone Jack (PHONES)
- ④ Power Switch/Master Volume (POWER/VOL)
- ⑤ Click Volume (CLICK VOL)
- ⑥ Accompaniment Volume (ACCOMP VOL)
- ⑦ LCD Display
- ⑧ Play Button (PLAY)
- ⑨ Utility Button (UTIL)
- ⑩ Click Button (CLICK)
- ⑪ Trigger Button (TRIG)
- ⑫ Voice Button (VOICE)
- ⑬ Song Button (SONG)
- ⑭ Start/Stop Button (START/S)
- ⑮ Save/Enter Button (SAVE/ENT)
- ⑯ Shift Button (SHIFT)
- ⑰ Page Button [PAGE ▲, PAGE ▼]
- ⑱ Select Button [SEL ◀, SEL ▶]
- ⑲ Value Button (VALUE-, VALUE+)

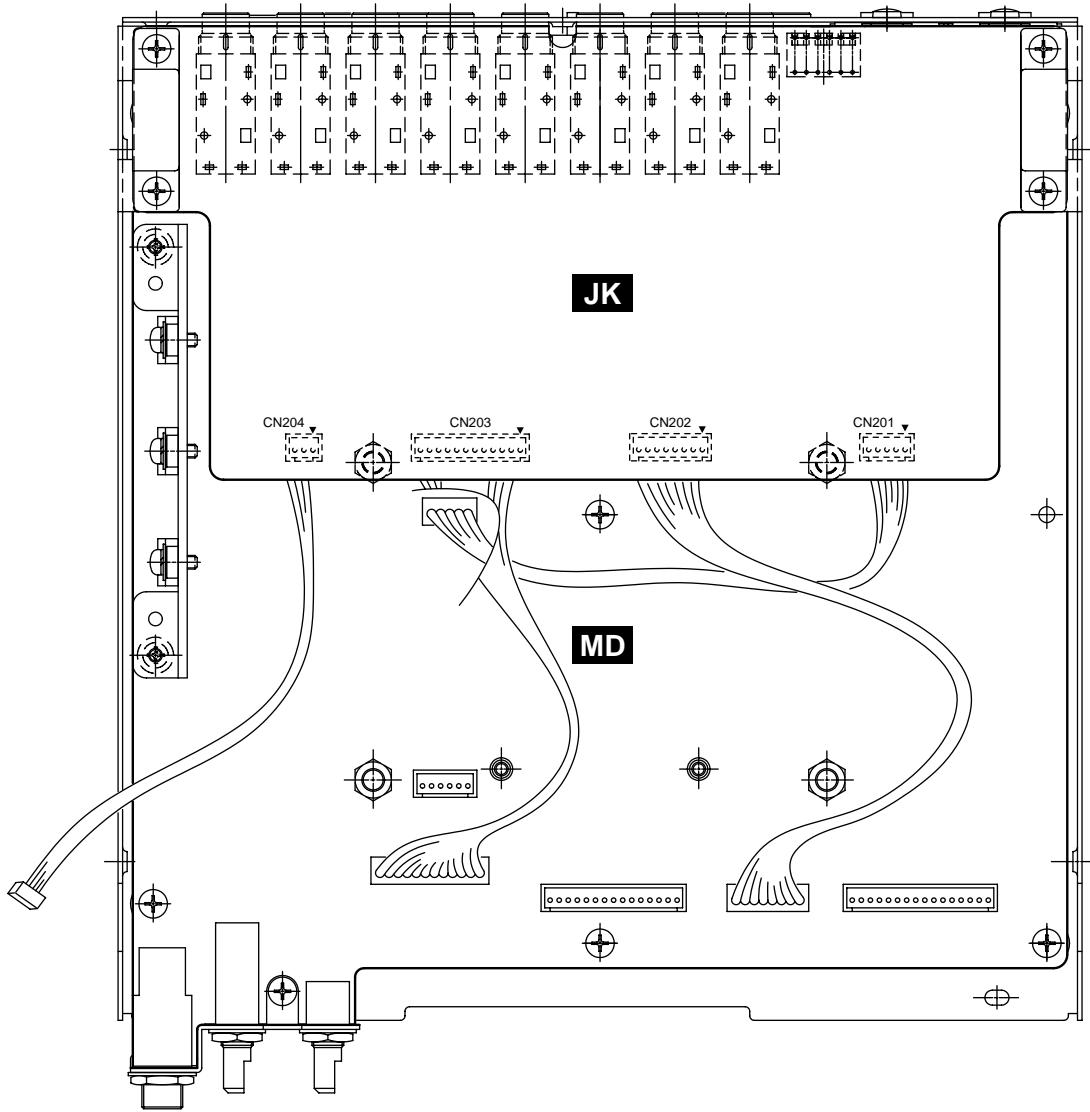
• Front Panel



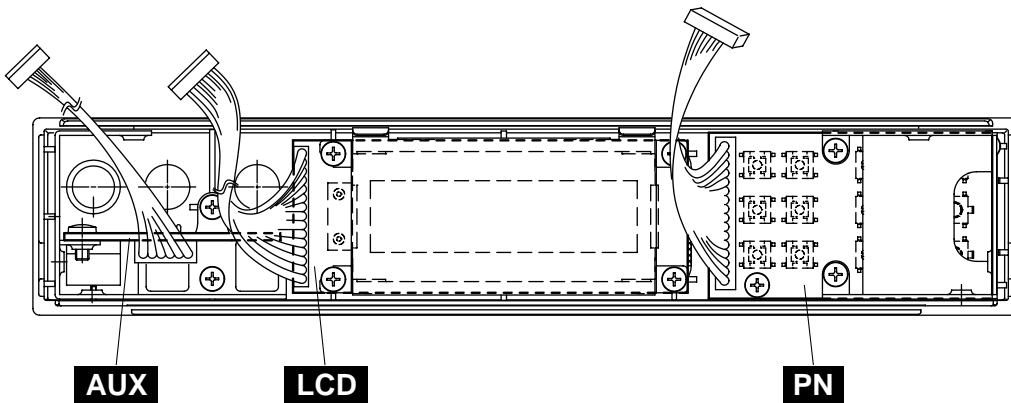
- ① MIDI IN/OUT Jack
- ② Input Attenuation Switch (INPUT ATTENUATION)
- ③ Trigger Input Jack (1 KICK-8 HI HAT)
- ④ Trigger Input Jack (9/10)
- ⑤ Hi-Hat Controller Jack (HI HAT CONTROL)
- ⑥ Host Select Switch
(HOST SELECT Mac/PC-1/PC-2/MIDI)
- ⑦ TO HOST Jack
- ⑧ Output Jacks (OUTPUT L/MONO, R)
- ⑨ Power Supply Jack (DC IN 12V)
- ⑩ Cord Hook

CIRCUIT BOARD LAYOUT

• Chassis Unit



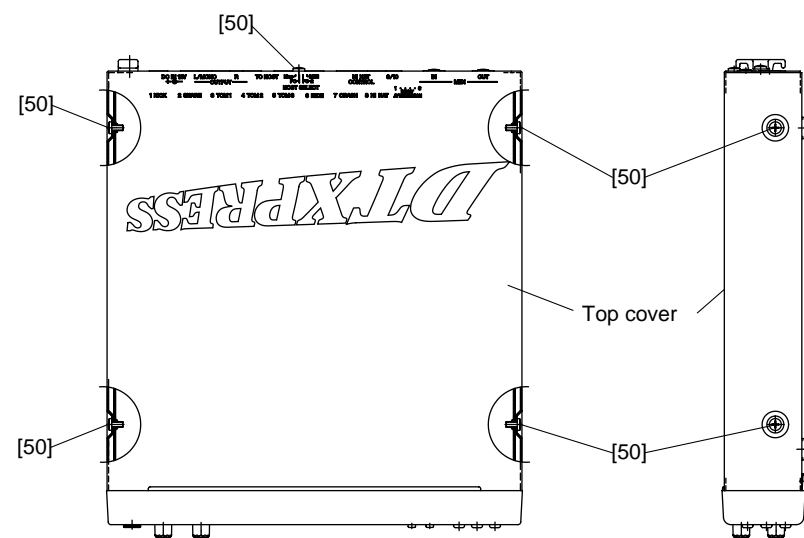
• Front Panel



DISASSEMBLY PROCEDURE

1 Top Cover

- 1-1 Remove the five (5) screws marked [50]. The top cover can then be removed. (Fig. 1)



[50]: Bind Head Tapping Screw-B 3.0X6 MFZN2BL (EP600230)

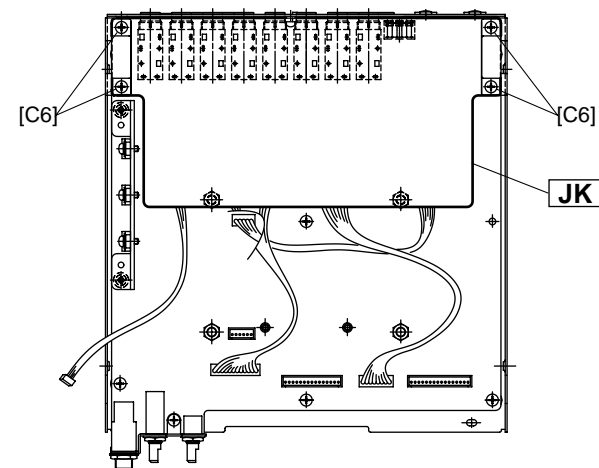
(Fig. 1)

2 Front Panel Unit

- 2-1 Remove the top cover. (See Procedure 1.)
2-2 Remove the four (4) screws marked [10c]. The front panel unit can then be removed. (Fig. 3)

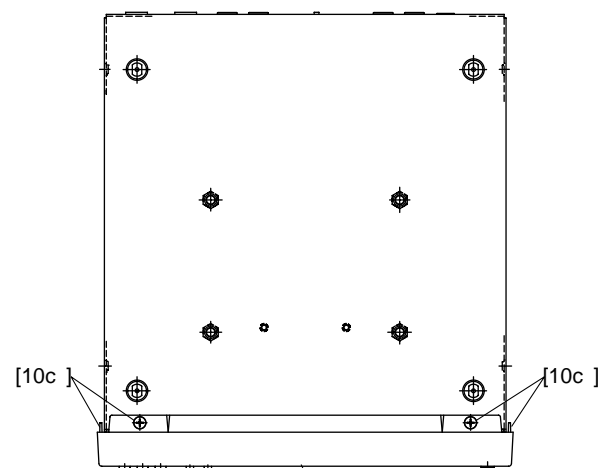
3 JK Circuit Board Assembly

- 3-1 Remove the top cover. (See Procedure 1.)
3-2 Remove the four (4) screws marked [C6]. The JK circuit board assembly can then be removed. (Fig. 2)



[C6]: Bind Head Tapping Screw-B 3.0X6 MFZN2BL (EP600230)

(Fig. 2)

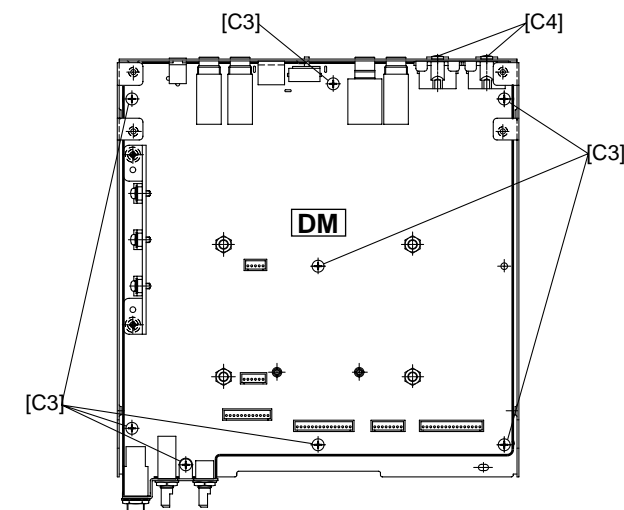


[10c]: Bind Head Tapping Screw-B 3.0X6 MFZN2BL (EP600230)

(Fig. 3)

4 DM Circuit Board Assembly

- 4-1 Remove the top cover. (See Procedure 1.)
4-2 Remove the front panel unit. (See Procedure 2.)
4-3 Remove the JK circuit board assembly. (See Procedure 3.)
4-4 Remove the eight (8) screws marked [C3] and the two (2) screws marked [C4]. The DM circuit board assembly can then be removed. (Fig. 4)



[C3]: Bind Head Tapping Screw-B 3.0X6 MFZN2BL (EP600230)
[C4]: Bind Head Tapping Screw-B 3.0X8 MFZN2BL (EP600190)

(Fig. 4)

5 LCD Circuit Board Assembly

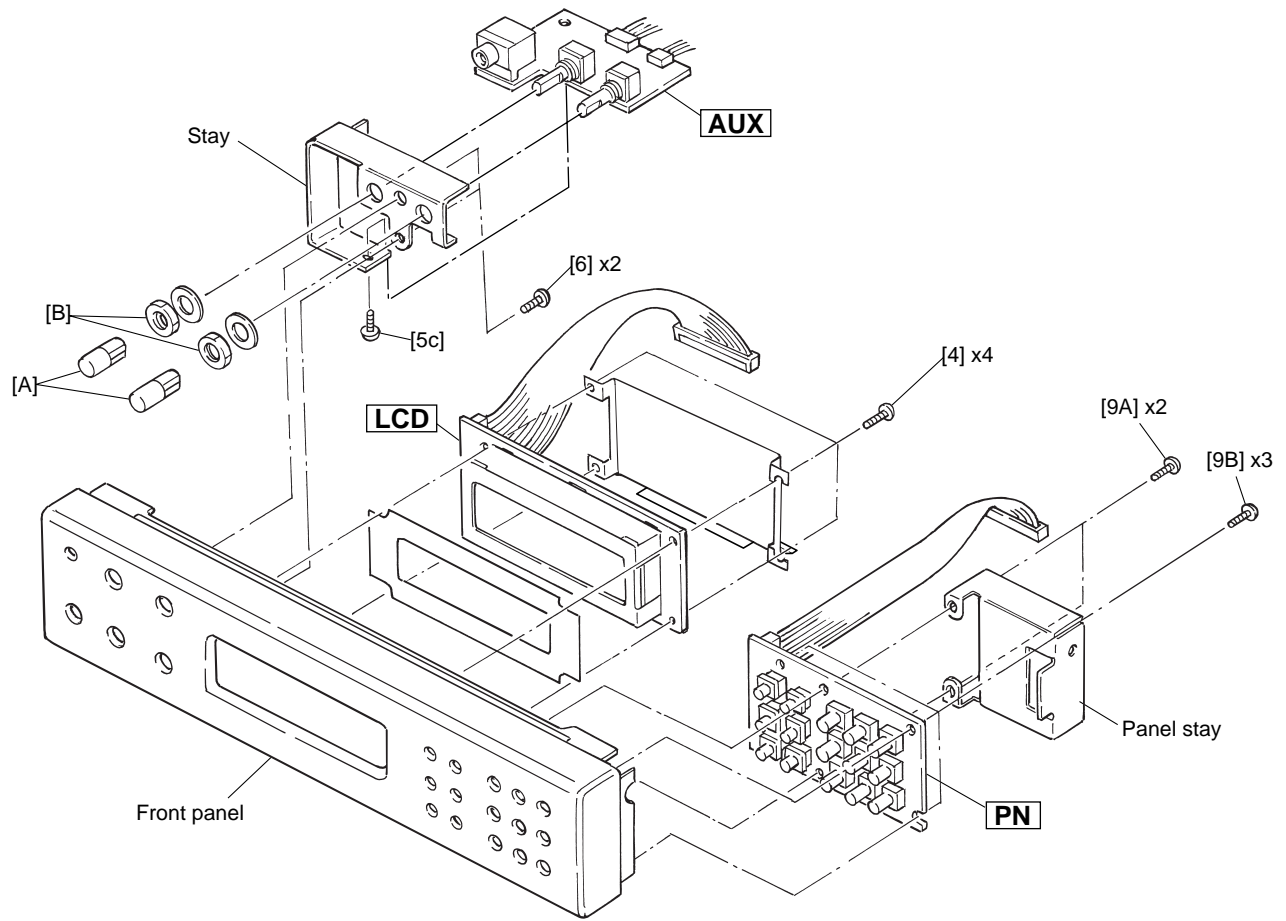
- 5-1 Remove the top cover. (See Procedure 1.)
5-2 Remove the front panel unit. (See Procedure 2.)
5-3 Remove the four (4) screws marked [4]. The LCD circuit board assembly can then be removed. (Fig. 5)

6 AUX Circuit Board Assembly

- 6-1 Remove the top cover. (See Procedure 1.)
6-2 Remove the front panel unit. (See Procedure 2.)
6-3 Remove the two (2) screws marked [6]. The AUX circuit board assembly with AUX stay can then be removed. Remove the two (2) knobs marked [A], the two (2) hexagonal nuts marked [B] and the screw marked [5c]. The AUX circuit board can then be removed. (Fig. 5)

7 PN Circuit Board Assembly

- 7-1 Remove the top cover. (See Procedure 1.)
7-2 Remove the front panel unit. (See Procedure 2.)
7-3 Remove the two (2) screws marked [A9], the panel stay and the three (3) screws marked [B9]. The PN circuit board assembly can then be removed. (Fig. 5)



- [4]: Bind Head Tapping Screw-P 2.6X8 MFZN2Y (EP620100)
 [5c]: Bind Head Tapping Screw-B 3.0X6 MFZN2BL (EP600230)
 [6]: Bind Head Tapping Screw-B 2.6X8 MFZN2Y (EP620100)
 [9]: Bind Head Tapping Screw-P 2.6X8 MFZN2BL (EP620100)

(Fig. 5)

LSI PIN DESCRIPTION

• HG73C205FD (XU947A00) SWX000 TONE GENERATOR DM IC001

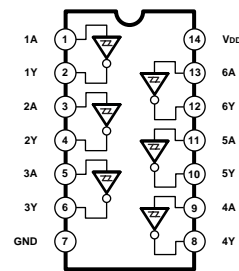
PIN No.	NAME	I/O	FUNCTION	PIN No.	NAME	I/O	FUNCTION
1	ICN	I	Initial clear	85	CMA3	O	Program address bus
2	RFCLKI	I	PLL Clock	86	CMA8	O	Program address bus
3	TM2	I	PLL Control	87	CMA2	O	Program address bus
4	AVDD_PLL	I	Power supply	88	CRD	O	read signal
5	AVSS_PLL	I	Ground	89	CMA1	O	Program address bus
6	MODE0	I	SWX dual mode	90	CUB	O	high byte effective signal
7	VCC7	I	Power supply	91	VCC91	I	Power supply
8	GND8	I	Ground	92	GHND92	I	Ground
9	XIN	I	crystal oscillator	93	CS1	O	CS signal
10	XOUT	O	crystal oscillator	94	CMA0	O	Program address bus
11	MODE1	I	SWX separate mode	95	CLB	O	low byte effective signal
12	TEST0	I	TEST pin	96	CMA12	O	Program address bus
13	TESTON	I	TEST pin	97	CMA11	O	Program address bus
14	ANO-P40	I	A/D converter	98	CMA10	O	Program address bus
15	AN1-P41	I	A/D converter	99	CMA9	O	Program address bus
16	AN2-P42	I	A/D converter	100	GND100	I	Ground
17	AN3-P43	I	A/D converter	101	CWE	O	write signal
18	AVDD_AN	I	Power supply	102	CMA16	O	Program address bus
19	AVSS_AN	I	Ground	103	CMA15	O	Program address bus
20	TXD0	O	for MIDI or TO-HOST	104	CMA14	O	Program address bus
21	TXD1	O	for MIDI	105	CMA13	O	Program address bus
22	EXCLK	I	Crystal oscillator	106	CMD8	I/O	Program memory Data bus
23	SMD11	I/O	Wave memory data bus	107	CMD7	I/O	Program memory Data bus
24	SMD4	I/O	Wave memory data bus	108	CMD9	I/O	Program memory Data bus
25	SMD3	I/O	Wave memory data bus	109	CMD6	I/O	Program memory Data bus
26	SMD12	I/O	Wave memory data bus	110	CMD10	I/O	Program memory Data bus
27	SMD10	I/O	Wave memory data bus	111	CMD5	I/O	Program memory Data bus
28	SMD5	I/O	Wave memory data bus	112	CMD11	I/O	Program memory Data bus
29	SMD2	I/O	Wave memory data bus	113	CMD4	I/O	Program memory Data bus
30	SMD13	I/O	Wave memory data bus	114	CMD12	I/O	Program memory Data bus
31	SMD9	I/O	Wave memory data bus	115	CMD3	I/O	Program memory Data bus
32	SMD6	I/O	Wave memory data bus	116	CMD13	I/O	Program memory Data bus
33	SMD1	I/O	Wave memory data bus	117	CMD2	I/O	Program memory Data bus
34	SMD14	I/O	Wave memory data bus	118	CMD14	I/O	Program memory Data bus
35	VCC35	I	Power supply	119	VCC119	I	Power supply
36	GND36	I	Ground	120	GND115	I	Ground
37	SMD8	I/O	Wave memory data bus	121	CMD1	I/O	Program memory Data bus
38	SMD7	I/O	Wave memory data bus	122	CMD15	I/O	Program memory Data bus
39	SMD0	I/O	Wave memory data bus	123	CMD0	I/O	Program memory Data bus
40	SMD15	I/O	Wave memory data bus	124	CMA21	O	Program address bus
41	SOE	O	read signal	125	PDT15	I/O	SWX access data bus
42	SWE	O	write signal	126	PDT14	I/O	SWX access data bus
43	SRAS	O	RAS signal	127	PDT13	I/O	SWX access data bus
44	SCAS	O	CAS signal	128	PDT12	I/O	SWX access data bus
45	REFRESH	O	REFRESH signal	129	PDT11	I/O	SWX access data bus
46	CS0	O	CS signal	130	PDT10	I/O	SWX access data bus
47	SMA0	O	Memory address bus	131	PDT9	I/O	SWX access data bus
48	SMA16	O	Memory address bus	132	PDT8	I/O	SWX access data bus
49	VCC49	I	Power supply	133	VCC133	I	Power supply
50	GND50	I	Ground	134	GND134	I	Ground
51	SMA1	O	Memory address bus	135	PDT7	I/O	SWX access data bus
52	SMA15	O	Memory address bus	136	PDT6	I/O	SWX access data bus
53	SMA2	O	Memory address bus	137	PDT5	I/O	SWX access data bus
54	SMA14	O	Memory address bus	138	PDT4	I/O	SWX access data bus
55	SMA3	O	Memory address bus	139	PDT3	I/O	SWX access data bus
56	SMA13	O	Memory address bus	140	PDT2	I/O	SWX access data bus
57	SMA4	O	Memory address bus	141	PDT1	I/O	SWX access data bus
58	SMA12	O	Memory address bus	142	PDT0	I/O	SWX access data bus
59	SMA5	O	Memory address bus	143	VCA143	I	Power supply
60	GND60	I	Ground	144	GND144	I	Ground
61	VCC61	I	Power supply	145	PAD2	I	SWX access address bus
62	SMA11	O	Memory address bus	146	PAD1	I	SWX access address bus
63	SMA6	O	Memory address bus	147	PAD0	I	SWX access address bus
64	SMA10	O	Memory address bus	148	VCC148	I	Power supply
65	SMA7	O	Memory address bus	149	GND149	I	Ground
66	SMA9	O	Memory address bus	150	PCS	I	Chip select
67	SMA17	O	Memory address bus	151	PWR	I	write enable
68	SMA8	O	Memory address bus	152	PRD	I	read enable
69	SMA18	O	Memory address bus	153	RXD0	I	for Midi or TO-HOST
70	SMA19	O	Memory address bus	154	RXD1	I	for Midi or Key scan
71	SMA20	O	Memory address bus	155	SCLKI	I	EXT Clock
72	SMA21	O	Memory address bus	156	ADIN	I	A/D converter
73	SMA22	O	Memory address bus	157	ADLR	O	A/D converter LR clock
74	SMA23	O	Memory address bus	158	DO0	O	DAC
75	CMA20	O	Program address bus	159	DO1	O	DAC
76	CMA19	O	Program address bus	160	SYSCLK	O	1/2 clock
77	VCC77	I	Power supply	161	VCC161	I	Power supply
78	GND78	I	Ground	162	GND162	I	Ground
79	CMA18	O	Program address bus	163	WCLK	O	for DAC LR clock
80	CMA17	O	Program address bus	164	QLCK	O	1/12 clock
81	CMA5	O	Program address bus	165	BCLK	O	IIS-DAC clock
82	CMA6	O	Program address bus	166	SYI	I	Synch signal
83	CMA4	O	Program address bus	167	IRQ0	I	Interrupt request
84	CMA7	O	Program address bus	168	NMI	I	Interrupt request

● **μPD63200GS-E1** (XP867A00) DAC (Digital to Analog Converter) DM IC007

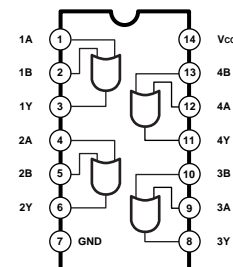
PIN No.	NAME	I/O	FUNCTION	PIN No.	NAME	I/O	FUNCTION
1	4/8FS	I	4/8 Fs selection	9	R. REF		Channel R voltage reference
2	D. GND		Digital ground	10	L. REF		Channel L voltage reference
3	16/8 BIT	I	16 bit/8 bit selection	11	L. OUT	O	Channel L output
4	D. VDD		Digital power supply	12	A. GND		Analog ground
5	A. GND		Analog ground	13	LRCX/WD	I	Left/right check, Word clock
6	R. OUT	O	Channel R output	14	LR/RSI	I	Left/right selection, Channel R series input
7	A. VDD		Analog power supply	15	SI/LSI	I	Series input/Channel L series input
8	A. VDD			16	CLK	I	Clock

■ IC BLOCK DIAGRAM

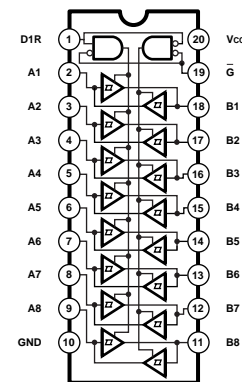
● **SN74HC14NSR** (XC725A00)
Inverter
AUX IC201,202



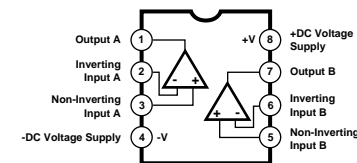
● **TC74HC32F-T1** (XD599A00)
OR
DM IC14



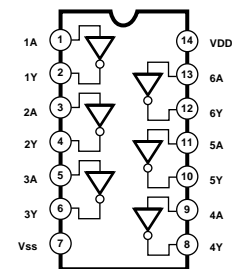
● **SN74HC245NSR** (XD838A00)
Buffer
DM IC11



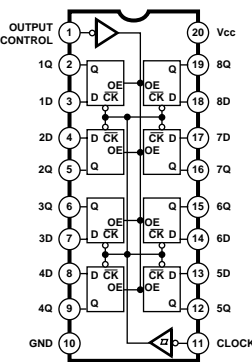
● **μPC4570G2** (XF291A00)
Dual Operational Amplifier
DM IC106,109,110, AUX IC501



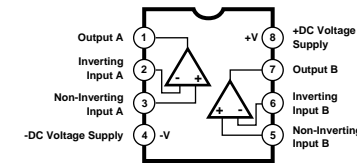
● **SC7SU04FEL** (XI348A00)
Hex Inverter
DM IC9,105



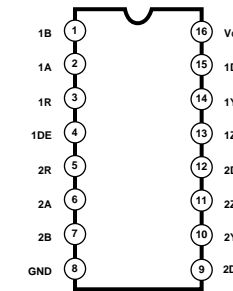
● **SN74HC374ANSR** (XQ042A00)
Octal 3-state D-Type Flip-Flop
DM IC12



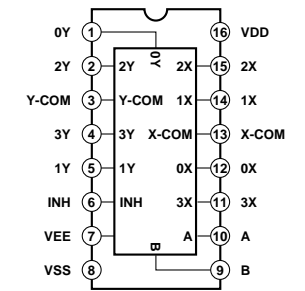
● **NJM4556AMT1** (XQ138A00)
Dual Operational Amplifier
DM IC108



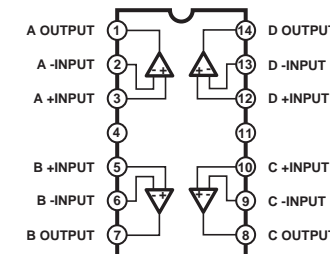
● **SN75C1168NSR** (XU073A00)
Line Driver
DM IC10



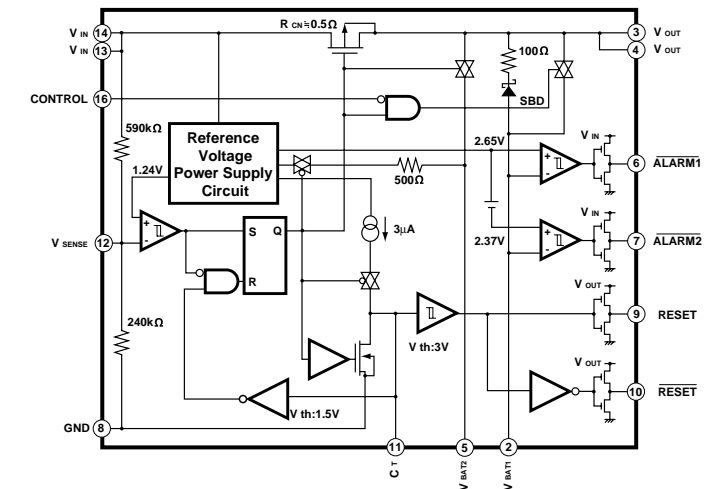
● **TC74HC4052AF** (XS790A00)
Multiplexer
AUX IC208,209



● **NJM2902M-T1** (XR562A00)
Quad Operational Amplifier
AUX IC203 to 207

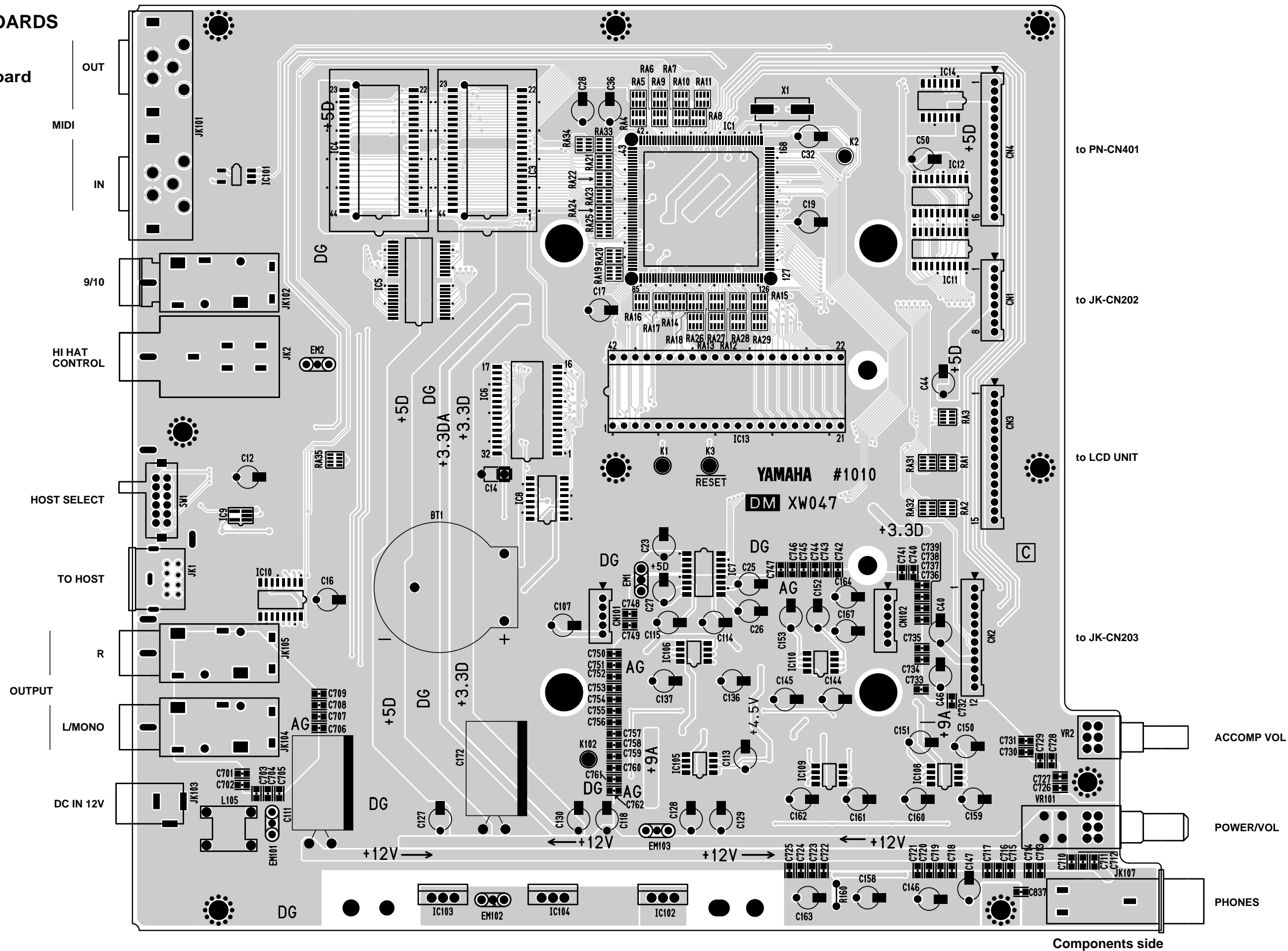


● **MB3790PF** (XR967A00)
ASSP
DM IC8

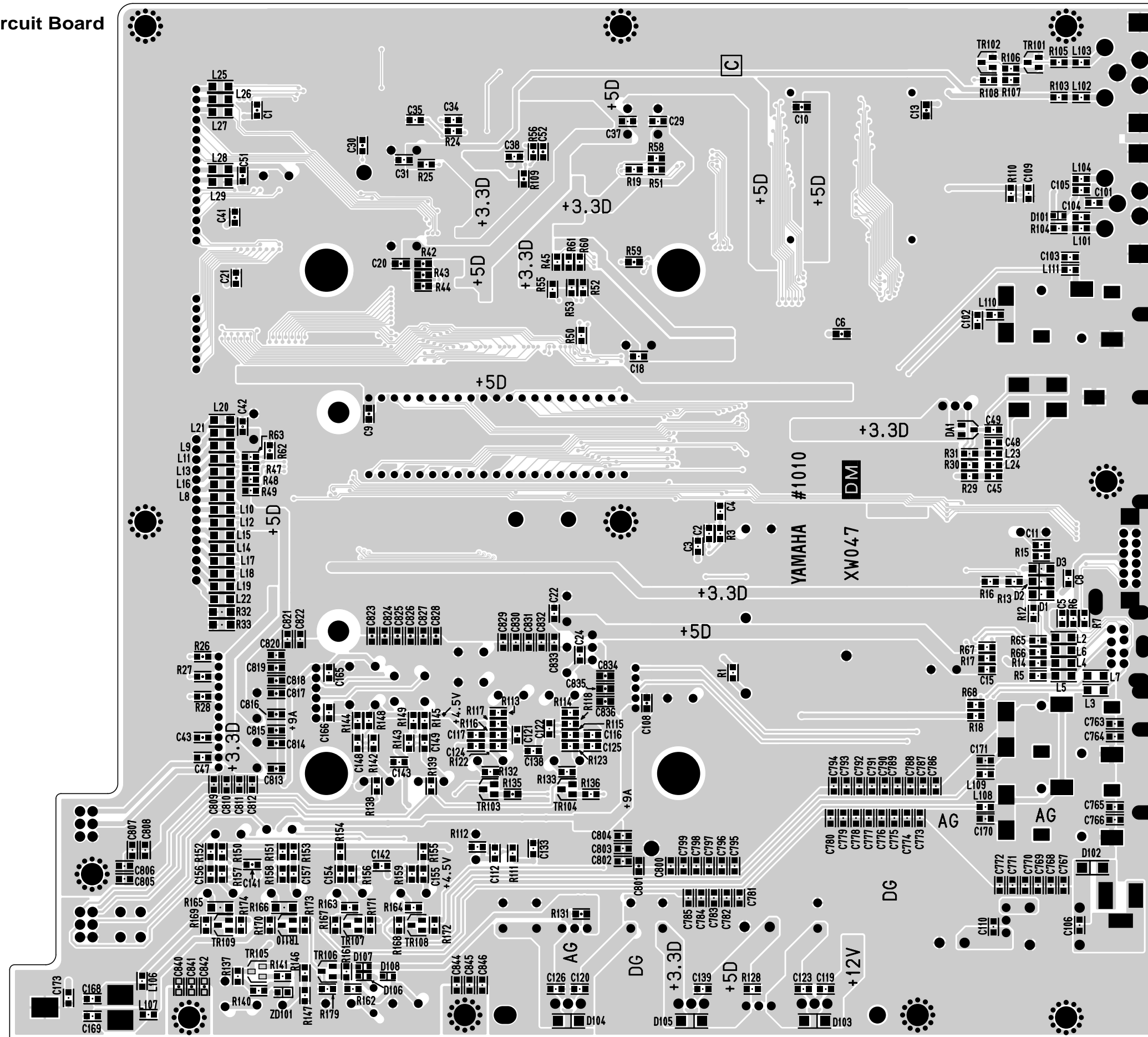


■ CIRCUIT BOARDS

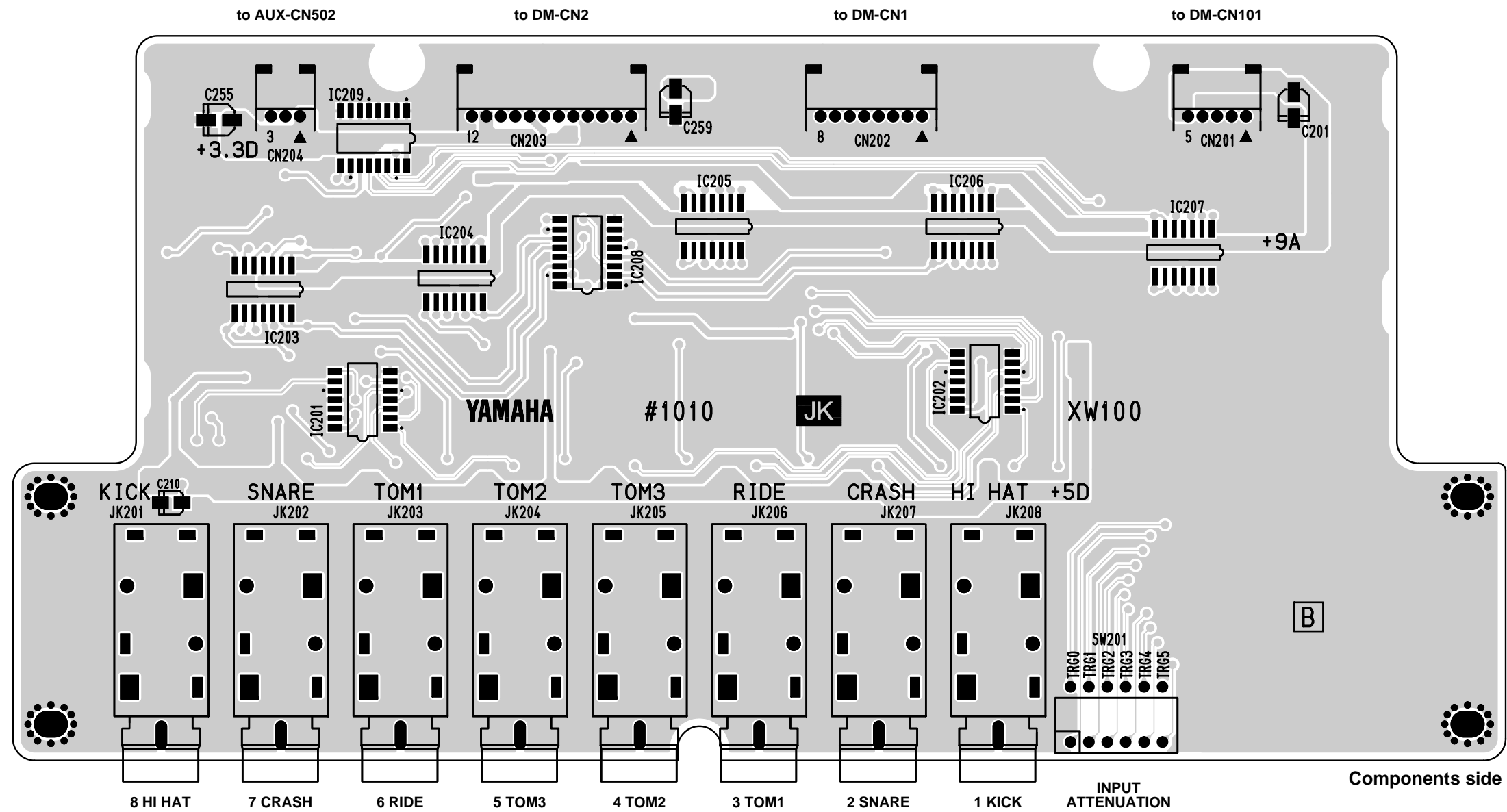
● DM Circuit Board



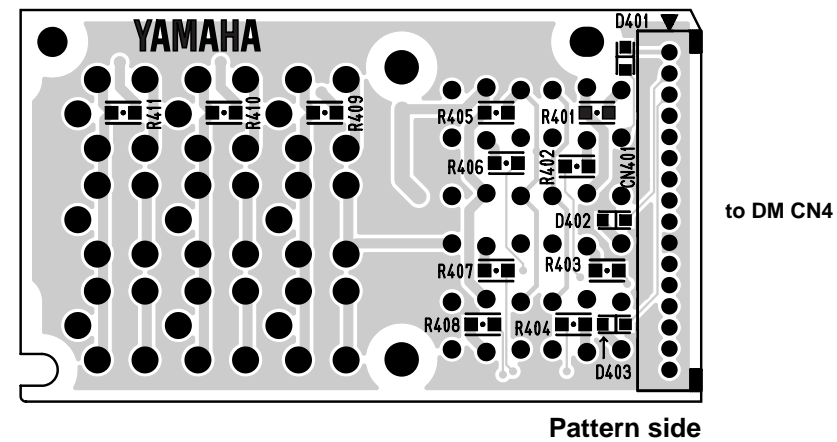
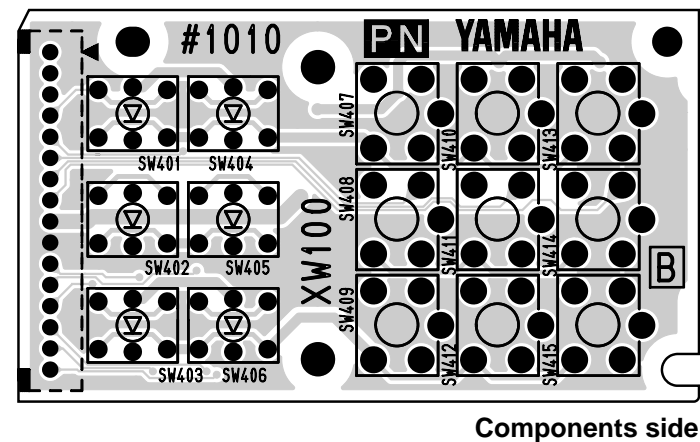
●DM Circuit Board



•JK Circuit Board

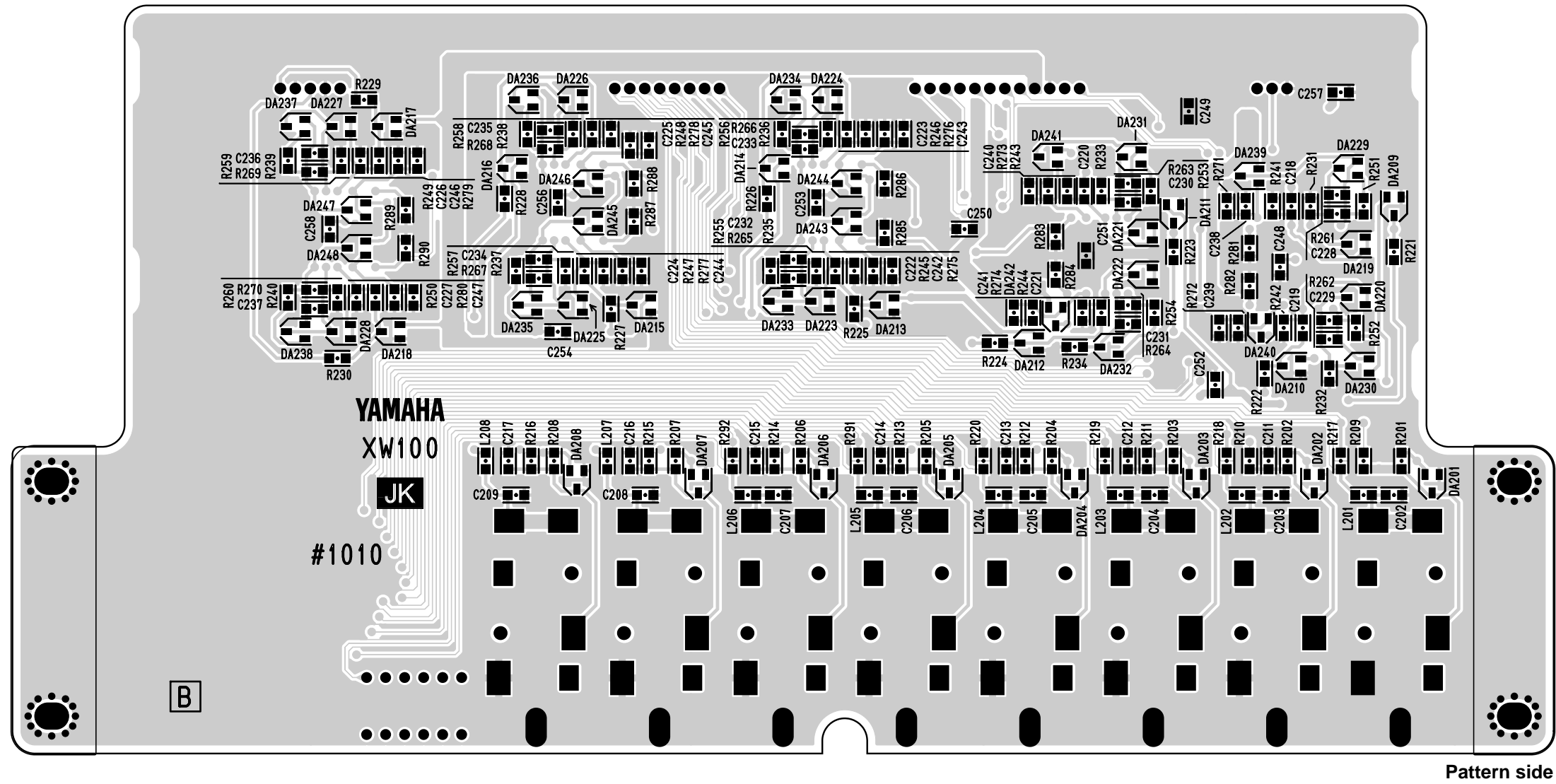


•PN Circuit Board

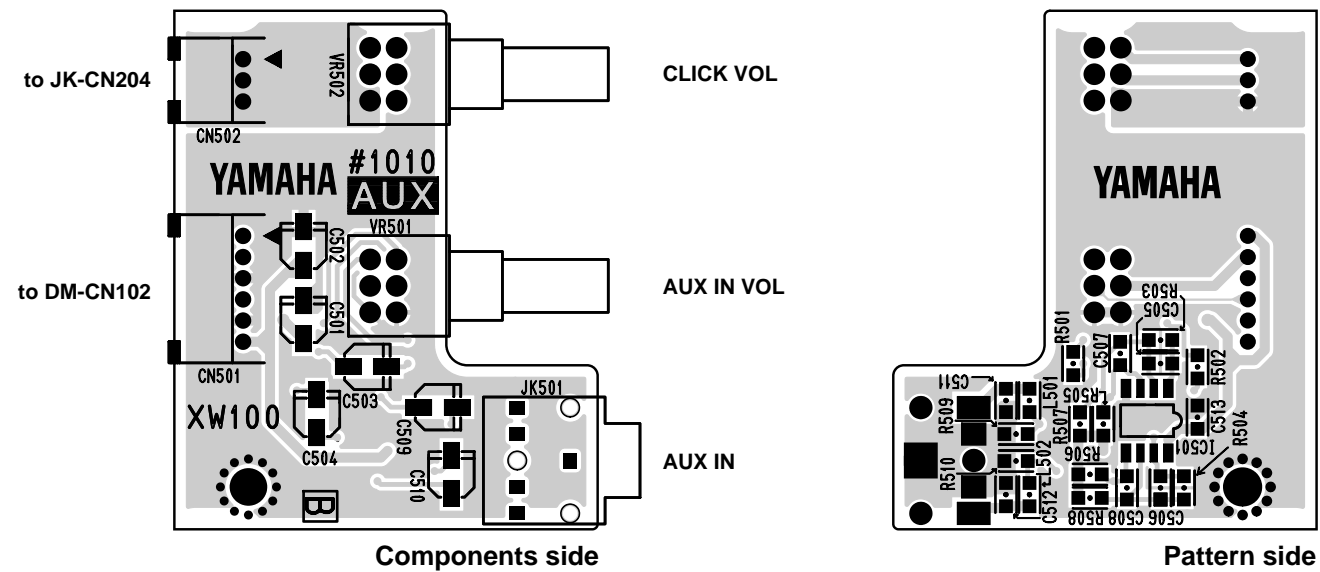


JK, PN: ENA-V374810

●JK Circuit Board



●AUX Circuit Board



JK, AUX: ENA-V374810

TEST PROGRAM

Test No.	Items	Judgment Criteria
T-01.	SRAM	SRAM READ/WRITE (AutomaticTest)
T-02.	WAVE ROM	WAVE ROM READ (Automatic Test)
T-03.	EFFECT DRAM	DRAM READ/WRITE (Automatic Test)
T-04.	BATTERY	Automatic Test
T-05.	MIDI	MIDI IN to OUT Connect
T-06.	TO HOST	TO HOST Loop Back Cable Connect
T-07.	CLICK VOL	Maximum, Minimum
T-08.	ACCOMP VOL	Maximum, Minimum
T-09.	LCD	Display of each pattern of LCD, Contrast
T-10.	LED	LED ON/OFF
T-11.	PANEL SWITCH	Panel SW ON
T-12.	ATTENUATOR SW IN 01	The loop signal is input from PHONES.
T-13.	ATTENUATOR SW IN 02	The loop signal is input from PHONES.
T-14.	ATTENUATOR SW IN 03	The loop signal is input from PHONES.
T-15.	ATTENUATOR SW IN 04	The loop signal is input from PHONES.
T-16.	ATTENUATOR SW IN 05	The loop signal is input from PHONES.
T-17.	ATTENUATOR SW IN 06	The loop signal is input from PHONES.
T-18.	TRIGGER IN 1	The loop signal is input from PHONES.
T-19.	TRIGGER IN 2	The loop signal is input from PHONES.
T-20.	TRIGGER IN 3	The loop signal is input from PHONES.
T-21.	TRIGGER IN 4	The loop signal is input from PHONES.
T-22.	TRIGGER IN 5	The loop signal is input from PHONES.
T-23.	TRIGGER IN 6	The loop signal is input from PHONES.
T-24.	TRIGGER IN 7	The loop signal is input from PHONES.
T-25.	TRIGGER IN 8	The loop signal is input from PHONES.
T-26.	TRIGGER IN 9	The loop signal is input from PHONES.
T-27.	TRIGGER IN 10	The loop signal is input from PHONES.
T-28.	RIM SW IN 1	Switch ON/OFF Check
T-29.	RIM SW IN 2	Switch ON/OFF Check
T-30.	RIM SW IN 3	Switch ON/OFF Check
T-31.	RIM SW IN 4	Switch ON/OFF Check
T-32.	RIM SW IN 5	Switch ON/OFF Check
T-33.	RIM SW IN 6	Switch ON/OFF Check
T-34.	RIM SW IN 7	Switch ON/OFF Check
T-35.	RIM SW IN 8	Switch ON/OFF Check
T-36.	HOST SELECT SW	HOST SELECT Switch Check
T-37.	H.H. CONT.	Maximum, Minimum
T-38.	OUTPUT L 1 kHz	Measurement
T-39.	OUTPUT R 1 kHz	Measurement
T-40.	OUTPUT L 10 kHz	Measurement
T-41.	OUTPUT R 10 kHz	Measurement
T-42.	OUTPUT L 50 Hz	Measurement
T-43.	OUTPUT R 50 Hz	Measurement
T-44.	AUX INPUT	Measurement
T-45.	32ch OUT	Listening
T-46.	FACTORY SET	
T-47.	EXIT	

A. How to enter the Program

While pressing the [PLAY] and [START/S] buttons turn the power switch on. When the test program is initiated, the Program ROM version will appear on the LCD display.

```
XX TEST MODE
Ver #.##
```

Note: The Ver #.## means the program ROM version.

A few second later, the following display appears:

```
01 SRAM
```

B. Proceeding through the Test Program

When entering the test program, the following display will appear.

```
01 SRAM
```

To select a test program number, use the [◀ SEL.] or [SEL. ▶] buttons. After making your selection, push the [SAVE/ENT.] button to begin the test program. It will proceed automatically.

If the test fails, the [FAIL] message is displayed on the LCD. To move on to another test program when the test has failed, depress the [SHIFT] button and select the new test program.

Exception: If test number T-11 fails, turn the power switch off and re-enter the test program.

T-01. SRAM

Initial Display

```
01 SRAM
```

Executes a write/read/verify test of SRAM (IC6).

Result Screens

OK: It proceeds to the next test automatically.

NG

```
01 SRAM
FAIL
```

Test End

OK: It proceeds to the next test automatically.

If an error is detected during the test, refer to section B, [PROCEEDING THROUGH THE TEST].

T-02. WAVE ROM

Initial Display

```
02 WAVE ROM
```

Reads and verifies the WAVE ROMs (IC3, IC4) through the SWX00.

Result Screens

OK: It proceeds to the next test automatically.

NG

```
02 WAVE ROM
FAIL WROM IC3
```

Test End

OK: It proceeds to the next test automatically.

If an error is detected during the test, refer to section B, [PROCEEDING THROUGH THE TEST].

T-03. EFFECT DRAM

Initial Display

```
03 EFFECT DRAM
```

Reads and verifies the DRAM (IC5) through the SWX00.

Result Screens

OK: It proceeds to the next test automatically.

NG

```
03 EFFECT DRAM
FAIL
```

Test End

OK: It proceeds to the next test automatically.

If an error is detected during the test, refer to section B, [PROCEEDING THROUGH THE TEST].

T-04. BATTERY

Initial Display

```
04 BATTERY
```

Checks battery strength.

Result Screens

OK: It proceeds to the next test automatically.

NG

```
04 BATTERY
FAIL
```


Test End

OK: It proceeds to the next test automatically.
If an error is detected during the test, refer to section B, [PROCEEDING THROUGH THE TEST].

T-05. MIDI**Initial Display**

05	MIDI
----	------

This test checks the MIDI IN and MIDI OUT operation. Before starting the test, connect the MIDI IN and MIDI OUT connectors using a MIDI cable.

Result Screens

OK: It proceeds to the next test automatically.

NG

05	MIDI
	FAIL

Test End

OK: It proceeds to the next test automatically.
If an error is detected during the test, refer to section B, [PROCEEDING THROUGH THE TEST].

T-06. TO HOST**Initial Display**

06	TO HOST
----	---------

The factory utilizes this test, and it is not intended for field service use.

T-07. CLICK VOL**Initial Display**

07	CLICK VOL
	XX

Checks that the CLICK volume knob operates normally. The numbers 00 to 99 will be indicated on the MEASURE INPUT part of the LCD when turning the CLICK volume from minimum to maximum position or vice versa

Result Screens

OK: It proceeds to the next test automatically

NG

07	CLICK VOL
----	-----------

Test End

OK: It proceeds to the next test automatically.
If an error is detected during the test, refer to section B, [PROCEEDING THROUGH THE TEST].

T-08. ACCOMP.VOL**Initial Display**

08	ACCOMP VOL
	XX

Checks that the ACCOMP volume knob operates normally. The numbers 00 to 99 will be indicated on the MEASURE INPUT part the LCD when turning the ACCOMP volume from minimum to maximum position or vice versa.

Result Screens

OK: It proceeds to the next test automatically

NG

08	ACCOMP VOL
	FAIL

Test End

OK: It proceeds to the next test automatically.
If an error is detected during the test, refer to section B, [PROCEEDING THROUGH THE TEST].

T-09. LCD**Initial Display**

Blank

Check that all dots of the LCD brink. After checking the backlight, press the [SAVE/ENT.] button.

Result Screens

Blank

Test End

OK: It proceeds to the next test automatically.

T-10. LED**Initial Display**

10	LED
----	-----

Use this test to visually confirm that all LEDs are producing appropriate brightness. Panel LEDs light the following order:

[PLAY]
[UTIL.]
[CLICK]
[TRIG.]
[KIT]
[SONG]

↓
This test mode lights all LEDs, then ends.

Result Screens

Blank

Test End

Press the [SAVE/ENT.] button. The DTXPRESS will automatically proceed to the next test.

T-11. Panel Switch**Initial Display**

```
11 SW
```

This test checks the panel switches.

Press the panel switches one by one from [PLAY] to [VALUE+] button in the order displayed on the LCD.

The test orders are as follows:

```
11 SW
[PLAY]
```

```
[PLAY], [UTIL.], [CLICK], [TRIG.], [VOICE]
[SONG], [START], [SAVE/], [SHIFT], [PAGE-]
[SEL <], [VAL-], [PAGE+], [SEL >], [VAL+]
```

Result Screens

OK: It proceeds to the next test automatically

NG

```
11 SW
FAIL
```

Test End

OK: It proceeds to the next test automatically.

If an error is detected during the test, refer to section B, [PROCEEDING THROUGH THE TEST].

T-12. Attenuator Switch IN 01**T-13. Attenuator Switch IN 02****T-14. Attenuator Switch IN 03****T-15. Attenuator Switch IN 04****T-16. Attenuator Switch IN 05****T-17. Attenuator Switch IN 06****Initial Display**

```
12 ATT. SW IN01
waiting      too Lo
```

Flip the attenuator switch to the down position. (Switch SW1-6 to the down position.)

Insert one end of, the stereo cable into the PHONES jack and the other into the 1.KICK jack. Then check whether there is signal leakage from any of the other inputs.

OK

```
13 ATT. SW IN02
waiting
```

When the next attenuator switch number appears in the display (e.g. IN02), insert the appropriate end of the stereo cable into the relevant jack (e.g. 2.SNARE). Repeat this process for all remaining switches.

Result Screens

OK: It proceeds to the next test automatically

NG

```
12 ATT. SW IN01
FAIL
```

Test End

OK: It proceeds to the next test automatically.

If an error is detected during the test, refer to section B, [PROCEEDING THROUGH THE TEST].

T-18. TRIGGER IN 01: 1 KICK**T-19. TRIGGER IN 02: 2 SNARE****T-20. TRIGGER IN 03: 3 TOM1****T-21. TRIGGER IN 04: 4 TOM2****T-22. TRIGGER IN 05: 5 TOM3****T-23. TRIGGER IN 06: 6 RIDE****T-24. TRIGGER IN 07: 7 CRASH****T-25. TRIGGER IN 08: 8 HIHAT****T-26. TRIGGER IN 09: 9/10****T-27. TRIGGER IN 10: 9/10****Initial Display**

```
18 TRIGGER IN01
waiting      too Lo
```

Flip the attenuator switch to the down position. (Switch SW1-6 to the down position.)

Insert one end of, the stereo cable into the PHONES jack and the other into the 1.KICK jack. Then check whether there is signal leakage from any of the other inputs.

OK

```
19 TRIGGER IN02
waiting      too Lo
```

When the next attenuator switch number appears in the display (e.g. IN02), insert the appropriate end of the stereo cable into the relevant jack (e.g. 9/10). Repeat this process for all remaining switches.

Result Screens

OK: It proceeds to the next test automatically.

NG

```
18 TRIGGER IN01
FAIL XXXXX
```

(XXXXXX= too High; too Lo; XtalkIN 2; BAD curve)

Test End

OK: It proceeds to the next test automatically.
 If an error is detected during the test, refer to section B, [PROCEEDING THROUGH THE TEST].

- T-28. RIM SW IN 1: 1 KICK
- T-29. RIM SW IN 2: 2 SNARE
- T-30. RIM SW IN 3: 3 TOM1
- T-31. RIM SW IN 4: 4 TOM2
- T-32. RIM SW IN 5: 5 TOM3
- T-33. RIM SW IN 6: 6 RIDE
- T-34. RIM SW IN 7: 7 CRASH
- T-35. RIM SW IN 8: 8 HIHAT

Initial Display

28 RIM SW IN01
 waiting

The pad with the RIM switch must be connected to one of (1.KICK to 8.HI.HAT). Check for signal leakage.

28 RIM SW IN01
 waiting

OK

29 RIM SW IN02
 waiting

When the next attenuator switch number appears in the display (e.g. IN02), insert the appropriate end of the stereo cable into the relevant jack (e.g. 8.HI.HAT). Repeat this process for all remaining switches.

Result Screens

OK: It proceeds to the next test automatically.

NG

28 RIM SW IN01
 FAIL

Test End

OK: It proceeds to the next test automatically.
 If an error is detected during the test, refer to section B, [PROCEEDING THROUGH THE TEST].

T-36. HOST SELECT SW

Initial Display

36 HOST SELECT
 [XXXXXX]

(XXXXXX= MAC; PC-1; PC-2; MIDI)

This test checks the HOST SELECT switch.
 Set the HOST SELECT switch to match the display.

Result Screens

OK: It proceeds to the next test automatically.

NG

36 HOST SELECT
 FAIL

Test End

OK: It proceeds to the next test automatically.
 If an error is detected during the test, refer to section B, [PROCEEDING THROUGH THE TEST].

T-37. H.H. CONT

Initial Display

37 H.H. CONT

Insert the H. H. CONTROL plug and turn the potentiometer from maximum to minimum position.

Result Screens

OK: It proceeds to the next test automatically.

NG: Blank

Test End

OK: It proceeds to the next test automatically.

T-38. OUTPUT L 1kHz

Initial Display

38 OUTPUT L 1kHz

This test checks the OUTPUT (L/MONO) for the specified signal output level.

Insert the plugs into the OUTPUT (L/MONO and R) jacks. Set the MASTER volume to maximum and AUX IN volume to minimum. Use the frequency counter, oscilloscope, distortion meter and level meter (with flat filter) to measure frequency, waveform, distortion and output level.

Check that the AUX IN jack is unplugged and that the input voltage is less than -90 dBm.

Check points

Check that the output meets the following specifications:

OUTPUT (L/MONO):

1 kHz +/-3 Hz, sine wave, +0.6 +/-2 dBm (10 kohm load and distortion is less than 0.3 %)

OUTPUT (R):

Less than -65 dBm (w/ flat filter)

When the OUTPUT (R) is disconnected:

OUTPUT (L/MONO):

1 kHz +/-3 Hz, sine wave, -5.1 +/-2 dBm (10 kohm load and distortion is less than 0.3 %)

Test End

OK: It proceeds to the next test automatically.

T-39. OUTPUT R 1kHz**Initial Display**

39 OUTPUT L 1kHz

This test checks the OUTPUT (R) for the specified signal output level.

Insert the plugs into the OUTPUT (L/MONO and R). Set the MASTER volume to maximum and AUX IN volume to minimum. Use the frequency counter, oscilloscope, distortion meter and level meter (with flat filter) to measure frequency, waveform, distortion and output level. Check that the AUX IN jack is unplugged and that the input voltage is less than -90 dBm.

Check points

Check that the output meets the following specifications:

OUTPUT (L/MONO):

Less than -65 dBm (w/ flat filter)

OUTPUT (R):

1 kHz \pm 3 Hz, sine wave, +0.6 \pm 2 dBm (10 kohm load and distortion is less than 0.3 %)

OUTPUT (R):

Less than -65 dBm (w/ flat filter)

Test End

OK: It proceeds to the next test automatically.

T-40. OUTPUT L 10kHz**Initial Display**

40 OUTPUT L 10kHz

This test checks the OUTPUT (L/MONO) for the specified signal output level.

Insert the plugs into the OUTPUT (L/MONO and R). Set the MASTER volume to maximum and AUX IN volume to minimum. Use the frequency counter, oscilloscope, distortion meter and level meter (with flat filter) to measure frequency, waveform, distortion and output level. In the AUX IN, check that the plug is not inserted, and the input voltage is less than -90 dBm.

Check points

OUTPUT(L/MONO):

10 kHz \pm 3 Hz, sine wave, +3.0 \pm 2 dBm (10 kohm load and distortion is less than 0.3 %)

Test End

OK: It proceeds to the next test automatically.

T-41. OUTPUT R 10kHz**Initial Display**

41 OUTPUT R 10kHz

This test checks the OUTPUT (R) for the specified signal output level.

Insert the plugs into the OUTPUT (L/MONO and R). Set the MASTER volume to maximum and AUX IN volume to minimum. Use the frequency counter, oscilloscope, distortion meter and level meter (with flat filter) to measure frequency, waveform, distortion and output level. In the AUX IN, check that the plug is not inserted, and the input voltage is less than -90 dBm.

Check points

OUTPUT(L/MONO):

10 kHz \pm 3 Hz, sine wave, +3.0 \pm 2 dBm (10 kohm load and distortion is less than 0.3 %)

Test End

OK: It proceeds to the next test automatically.

T-42. OUTPUT L 50Hz**Initial Display**

42 OUTPUT L 50Hz

This test checks the OUTPUT (R) for the specified signal output level.

Insert the plugs into the OUTPUT (L/MONO and R) jacks. Set the MASTER volume to maximum and AUX IN volume to minimum. Use the frequency counter, oscilloscope, distortion meter and level meter (with flat filter) to measure frequency, waveform, distortion and output level.

Check that the AUX IN jack is unplugged and that the input voltage is less than -90 dBm.

Check points

OUTPUT(L/MONO):

50 Hz \pm 3 Hz, sine wave, +2.7 \pm 2 dBm (10 kohm load and distortion is less than 0.3 %)

Test End

OK: It proceeds to the next test automatically.

T-43. OUTPUT R 50Hz**Initial Display**

43 OUTPUT R 50Hz

This test checks the OUTPUT (R) for the specified signal output level.

Insert the plugs into the OUTPUT (L/MONO and R) jacks. Set the MASTER volume to maximum and AUX IN volume to minimum. Use the frequency counter, oscilloscope, distortion meter and level meter (with flat filter) to measure frequency, waveform, distortion and output level.

Check that the AUX IN jack is unplugged and that the input voltage is less than -90 dBm.

Check points

OUTPUT(R):

50 Hz +/-3 Hz, sine wave, +2.7 +/-2 dBm (10 kohm load)

Test End

OK: It proceeds to the next test automatically.

T-44. AUX INPUT

Initial Display

44 AUX INPUT

This test checks the AUX IN signal output to the PHONES for the specified signal output level.

The sign wave is input from the low frequency oscillation machine to AUX IN (L). The sine wave to the AUX IN(L) should be shorted to ground.

Insert the stereo phone plugs into the OUTPUT (L/MONO and R) jacks. Use the frequency counter, oscilloscope, distortion meter and level meter (with flat filter) to measure frequency, waveform, distortion and output level.

Check points

Apply a -2.0 dBm sine wave(10 kHz, 1 kHz and 50 Hz) to the AUX IN (L). AUX IN (R) should be shorted to ground. Set the AUX IN volume to maximum. Make the AUX IN volume and the mastering volume Maximum.

OUTPUT (L/MONO):

+4.3 +/-2 dBm (10 kohm load and distortion is less than 0.3 %) AUX IN (L) should be shorted to ground. Set the AUX IN volume to maximum.

OUTPUT (R):

+4.3 +/-2 dBm (10 kohm load and distortion is less than 0.3 %)

Apply a -2dBm sine wave (10 kHz, 1 kHz and 50 Hz) to the AUX IN (R). AUX IN (L) should be shorted to ground. Set the AUX IN volume to maximum.

Test End

OK: It proceeds to the next test automatically.

T-45. 32ch OUT

Initial Display

45 32 ch OUT

Checks that the correct sine wave signals are output from the unit. The signal from channels 1 to 16 is output from the left output jack, that from channels 17 to 32 is output from the right.

Press the [SAVE/ENT.] button. Then the signals are output 16 times (0.3 seconds on and 0.1 seconds off) for all 32 channels.

Set the MASTER volume to maximum.

45 32ch OUT
Lch=XX Rch=XX

XX indicates the sound output channels.

Check points

Check that all 32signals are output.

Check that it is a sine wave with a normal output crimp.

(Lch= 1 kHz, Rch= 700 Hz)

Test End

OK: It proceeds to the next test automatically.

T-46. FACTORY SET

Initial Display

46 FACTORY SET

This test sets parameters back to their factory values.

To initiate this reset, press the [SAVE/ENT.] button.

Test End

Blank

T-47. EXIT

Initial Display

47 EXIT

Exit from test mode.

Press the [SAVE/ENT.] button to exit from TEST mode.

The system responds to the EXIT by executing the normal power-up sequence. The system will require a few seconds to enable itself for normal play.

Comments

1. Measure the click noise produced whenever the power switch is turned on and off and also that produced by disconnecting the DC adaptor. The click noise level must not exceed 0.1V-pp at the terminals of OUTPUT(L/MONO,R).
2. Factory Reset
While depressing the [PAGE-] and [PAGE+] buttons, turn the power switch on.

MIDI DATA FORMAT

1. Channel Message

When the [2-2. Channel 10 Program Change/Channel Event Receive] in the utility mode is set to "10=off", the DTXPRESS will not receive channel message for MIDI channel 10.

1.1 Key On Key Off

Sends and receives data.

Receive note range: C-2 to G8
Velocity range: 1 to 127 (note on only)

1.2 Control Change

All control change data for sequencer functions can be received and transmitted. The following lists the tone generator functions and drum trigger functions.

1.2.1 bank select MSB-0

Sends and receives data.

data=0:normal voice
data=127:drum voice

The data will not be processed unless program change data is received.

1.2.2 modulation (No. 1)

Receives only.

1.2.3 foot controller (No. 4)

Sends and receives data.

1.2.3 data entry (No. 6)

Receives only. Used to specify RPN data.

1.2.5 main volume (No. 7)

Sends and receives data.

1.2.6 pan (No. 10)

Sends and receives data.

0 is the far left of a stereo image and 127 is the far right of a stereo image.

1.2.7 expression (No. 11)

Receives only.

1.2.8 hold1 (No. 64)

Receives only.

1.2.9 harmonic content (No. 71)

Receives only.

1.2.10 release time (No. 72)

Receives only.

1.2.11 attack time (No. 73)

Receives only.

1.2.12 brightness (No. 74)

Receives only.

1.2.13 portamento control (No. 84)

Receives only.

1.2.14 effect 1 depth (No. 91)

Receives only. Only effects the reverb send level.

1.2.15 data increment/decrement (No. 100/101)

Receives only.

1.2.16 RPN

00/00 pitch bend sensitivity: Receive only.
00/01 fine tuning: Receive only.
00/02 coarse tuning: Receive only.
7F/7F NULL: Receive only.

1.3 Channel Mode Message

All channel mode messages are received only.

1.3.1 all sound off (No. 120)

Mutes all the sounds currently playing through the specified channel.

1.3.2 reset all controllers (No. 121)

Sets the following controller values back to its initial value:
pitch bend, modulation, expression, hold1, portamento control,
RPN number

1.3.3 all note off (No. 123)

Turns off all the notes of the specified channel currently on.
They will however, not be muted unless "hold 1" is turned off.

1.3.4 omni off (No. 124)

Executes the same process as "all note off".

1.3.5 omni on (No. 125)

Executes the same process as "all note off".

1.3.6 mono (No. 126)

Executes the same process as "all sound off".

1.3.7 poly (No. 127)

Executes the same process as "all sound off".

1.4 Program Change

When the [2-3. Receive Program Change/System Exclusive Messages] in the utility mode is set to "PC=off", the DTXPRESS will not receive program change data.

When the [2-2. Channel 10 Program Change/Channel Event Receive] (P. 54) in the utility mode is set to "10PC=off", the DTXPRESS will not receive MIDI channel 10 program change data.

1.5 Pitch Bend

Sends and receives data.

1.6 Channel Aftertouch

Does not send or receive data.

1.7 Polyphonic Aftertouch

Does not send or receive data.

2. System Exclusive Message

When the [2-3. Receive Program Change/System Exclusive Messages] in the utility mode is set to "SySex=off", the DTXPRESS will not receive system exclusive messages.

The DTXPRESS will not receive system exclusive messages that do not match the device number set in the "DevNo=" of the [2-6. Device Number, Local Control] in the utility mode.

2.1 Parameter Change

2.1.1 GM system ON

F0 7E 7F 09 01 F7

Sets all the data except the MIDI master tuning data to its initial value.
Sends and receives data.

2.1.2 XG system ON

F0 43 1n 4C 00 00 7E 00 F7

"n" stands for device number.
Executes the same process as GM system ON.
Receives only.

2.1.3 identify request

F0 7E 0n 06 01 F7

"n" stands for device number.
After receiving, the identify reply is transmitted.
Receives only.

2.1.4 MIDI master volume

F0 7F 7F 04 01 XX mm F7

Ignores "XX". "mm" is the volume.
Receives only.

2.1.5 MIDI master tune

F0 43 1n 27 30 00 00 mm ll cc F7

"n" stands for device number.
The values of "mm(MSnible)" and "ll(LSnible)"—128 is used for 1 cent unit when tuning.
Receives only.

2.2 Bulk Dump

Sends and receives data. All the data except the system data is converted into 1 or 2 byte ASCII characters and transmitted.

- DTXPRESS bulk dump common message.

F0 43 7D Xn ss ss 44 54 58 4C("DTXL") tt tt tt ii jj jj dataBytes csum F7

tt tt tt This displays the ID of the bulk type. 4 characters of ASCII code.

ss ss data bytes (from model ID to data) MS7bit, LS7bit

ii ii data packet index number MS7bit, LS7bit
If the data size exceeds 4096, the total is divided into F0-F7 packets, the packet index number will start at 00 01 (0001) increasing by 1 for each successive packet. The last packet is 7F 7F (3FFF).

jj jj When the data size is less than 4096, it will be 00 00 (0000).
object number MS7bit, LS7bit
Object number. In the DTXPRESS system only 1 article exists, that will become 7F 7F (3FFF).

csum indicates the 7bit of the 2's complement of the sum of the data from the model ID (ss ss) to data Bytes.

2.2.1 system

F0 43 7D 0n ss ss 44 54 58 4C("DTXL") 53 59 53 54("SYST")
00 00 7F 7F data csum F7

2.2.2 map

F0 43 7D 0n ss ss 44 54 58 4C("DTXL") 55 4D 41 50("UMAP")
00 00 7F 7F data csum F7

2.2.3 drumkit

F0 43 7D 0n ss ss 44 54 58 4C("DTXL") 44 4B 49 54("DKIT")
00 00 jj jj data csum F7

jj jj Indicated by MS7bit, LS7bit. This number derived from the user drum kit number by counting from "0". In the case of the edit buffer, it is 7F 7F (3FFF).

2.2.4 trigger

F0 43 7D 0n ss ss 44 54 58 4C("DTXL") 54 52 49 47("TRIG")
00 00 jj jj data csum F7

jj jj The user trigger's number MS7bit, LS7bit.
7F 7F specifies the edit buffer

2.2.5 song

F0 43 7D 0n ss ss 44 54 58 4C("DTXL") 53 4F 4E 47("SONG")
ii ii jj jj data2 csum F7

jj jj The user song number's MS7bit, LS7bit.
7F 7F specifies the current song.

data 2 Divides the original data into the 4 bits MSnibble, LSnibble, and converts 1 byte data to 2 bytes.

2.3 Dump Request

Receives only.
Transmits the corresponding bulk dump.

F0 43 7D 2n 44 54 58 4C("DTXL") tt tt tt ii jj jj F7

jj jj object number MS7bit, LS7bit
Object number. In the DTXPRESS system only 1 article exists, that will become 7F 7F (3FFF).
The object number contains the number that specifies the drum kit number, etc.
Only one article exists, system data or edit buffer data, etc., that appoints 7F 7F (3FFF).
However, 7F 7F does not correspond in the case of song data.

3. System common message

3.1 Select a song

f3 nn

"nn" stands for song number.
Receives only.

4. Realtime message

Sends and receives data.

4.1 timing clock

Synchronizes with the timing clock received when the Sync mode in the utility mode's [3-6. Sync Mode] is set to "ext" or "auto".

4.2 start, continue, stop

When the [3-4. MIDI Control] in the utility mode is set to "MIDI Control=off", the DTXPRESS will not receive start, continue and stop.

4.3 active sensing

Once active sensing data has been received, if no MIDI data is subsequently received for longer than an interval of approximately 300 msec, the DTXPRESS will mute all the sounds.

Send the messages within an interval of approximately 300 msec.

■ ERROR MESSAGES

An Error Message will appear when incorrect settings or operation are detected, or abnormal operation occurs. Check the Error Message below and make the appropriate corrections.

ERROR
Data Initialized

This message appears just after the power is switched on and the device can not correctly read the data. The cause of the problem may be that the backup RAM data has been damaged or the backup battery power is low. Contact the nearest Yamaha Service Center or the dealer where you purchased the device.

WARNING
Battery Low

The internal memory backup battery power is too low. User data may be deleted. Contact the nearest Yamaha Service Center or the dealer where you purchased the device.

ERROR
MIDI Buffer full

Too much MIDI data is being received at one time and the device could not manage the data. Reduce the amount of data being sent at one time and try again.

ERROR
HOST is OffLine

The computer connected to the device is either turned off or not correctly connected. Check cable connections and the power and try again.

ERROR
Check Sum

The check sum for the data received is incorrect. Check the check sum of the data being transmitted.

ERROR
Illegal Data

An error occurred while data was being received. There may be abnormalities in the data being sent. Check the data being transmitted.

CAN'T EDIT
PRESET SONG

This message is displayed when you try to edit preset song. Preset song cannot be edited.

ERROR
SEQ is Running

The operation can't be performed while the sequencer is running. Stop the sequencer and try again.

ERROR
Data not Empty

This message appears if you try to record to a track containing data. Select an empty track and try recording again.

ERROR
Memory Full

You have exceeded the memory capacity of the user song. Delete unwanted songs to make more memory available and try recording again. At this time, use the bulk dump function to move any songs you wish to keep to an external MIDI device.

**YAMAHA [Drum Trigger Module]
Model DTXPRESS MIDI Implementation Chart**
**Date:5-Mar-1999
Version : 1.0**

Function ...		Transmitted	Recognized	Remarks
Basic Channel	Default Changed	1 - 16 1 - 16	1 - 16 1 - 16	memorized
Mode	Default Messages Altered	x x *****	3 3 x	
Note Number	: True voice	0 - 127 0 - 127	0 - 127 0 - 127	
Velocity	Note ON Note OFF	o 9nH,v=1-127 x 9nH,v=0	o v=1-127 x	
After Touch	Key's Ch's	x x	x x	
Pitch Bender		x	o	7 bit resolution
Control Change	0,4,7,10,32 1,6,11,64 71,72,73 74,84,91 100,101	o x x x x	o o o o o	
Prog Change	: True #	o 0 - 127 *****	o 0 - 127	
System Exclusive		o	o	
System Common	: Song Pos. : Song Sel. : Tune	x x x	x o x	
System Real Time	: Clock : Commands	o o	o o	
Aux Messages	: All Sound Off : Reset All Cntrls : Local ON/OFF : All Notes OFF : Active Sense : Reset	x x o x o x	o o o o(123-127) o x	

DRUM TRIGGER MODULE



PARTS LIST

■ CONTENTS


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Notes: DESTINATION ABBREVIATIONS

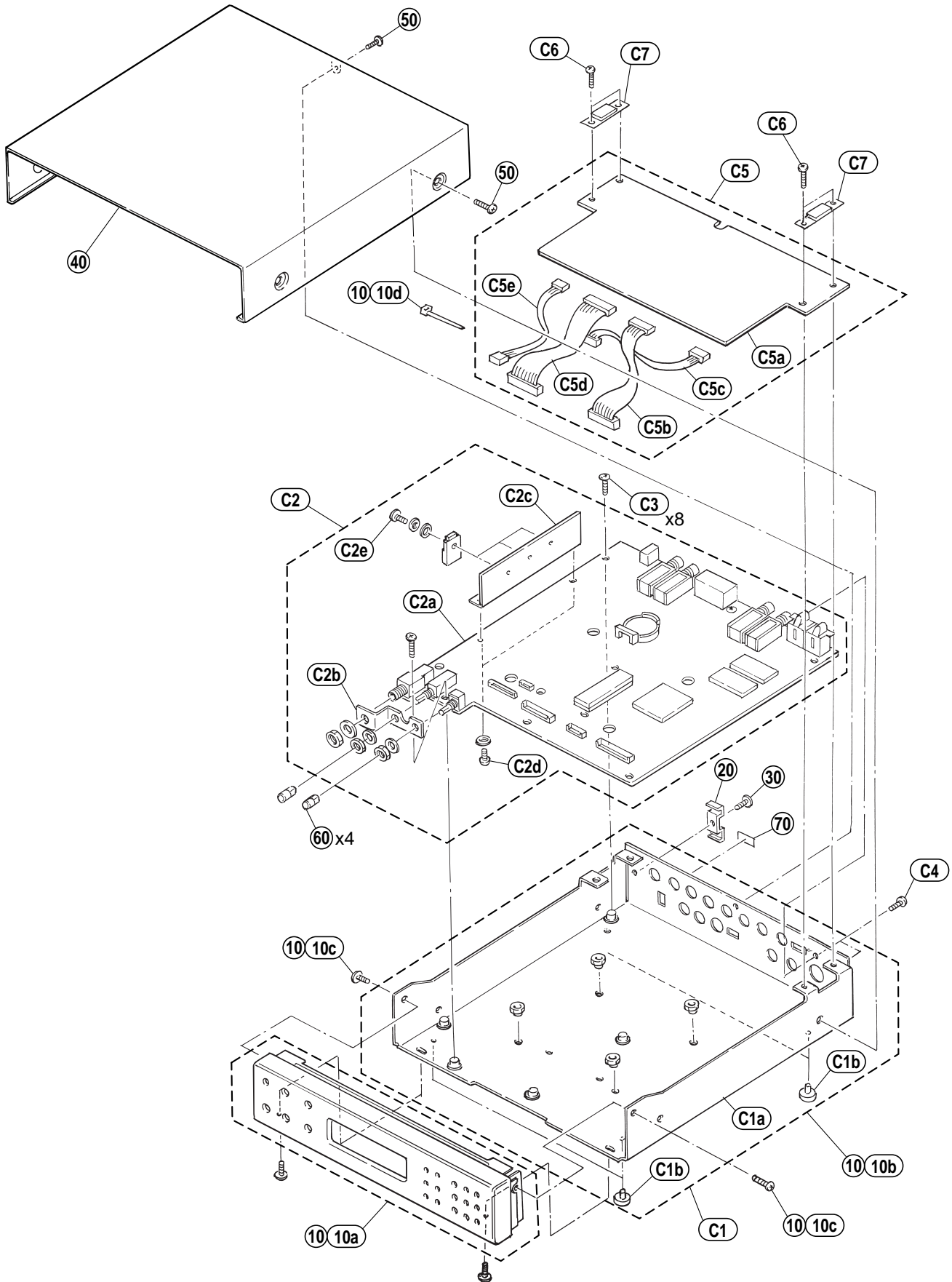
A :Australian model	J :Japanese model
B :British model	U :U.S. model
C :Canadian model	V :General export model (110V)
E :European model	W :General export model (220V)
H :North European model	X :General export model
I :Indonesian model	Y :Export model

- The numbers in "QTY" shows quantities for each unit.
- The parts with "--" in "Parts No." are not available as spare parts.
- The mark " } " in the remarks column indicates that these parts are interchangeable.
- The second letter of the shaded (■) part number is I, not one.

■ WARNING

Components having special characteristics are marked  and must be replaced with parts having specification equal to those originally installed.

OVERALL ASSEMBLY

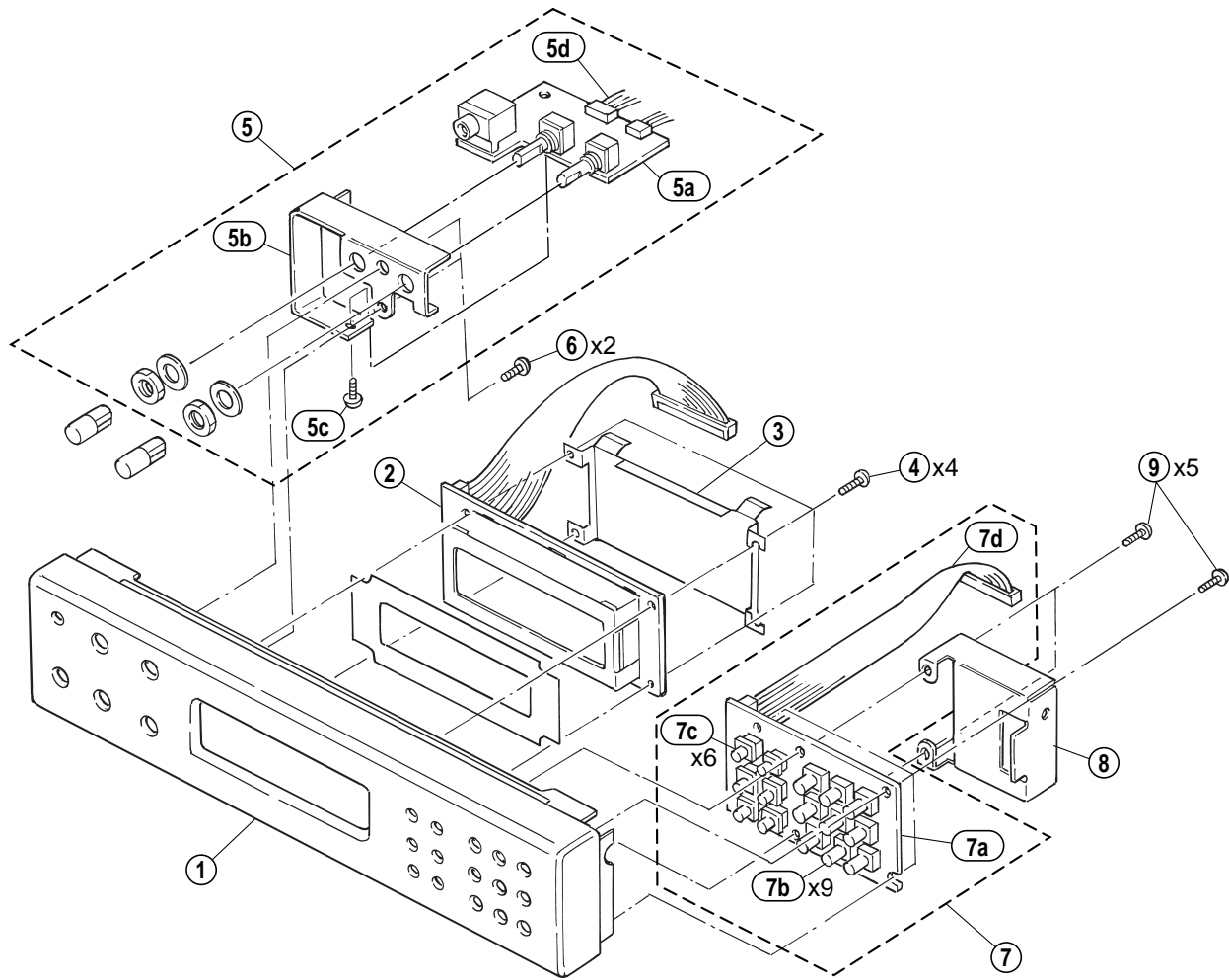


REF NO.	PART NO.	DESCRIPTION		REMARKS	QTY	RANK
		OVERALL ASSEMBLY		DTXPRESS J, U, C, N		
10	--	Overall Assembly		(V360740)		
10a	--	Sub Assembly		(V360720)		
10b	--	Front Panel Unit		(V360700)		
	--	Chassis Unit		(V360710)		
10c	EP600230	Bind Head Tapping Screw-B	3.0X6 MFZN2BL		4	01
10d	CB069250	Cord Holder	BK-1		3	01
20	VC407100	Cord Column				02
30	EP600190	Bind Head Tapping Screw-B	3.0X8 MFZN2BL			01
* 40	V3604800	Top Cover				
50	EP600230	Bind Head Tapping Screw-B	3.0X6 MFZN2BL		5	01
60	VM825600	Input Knob			4	03
70	--	Name Plate		(V360730)		
	--	Chassis Unit		(V360710)		
* C1	V3606300	Chassis Assembly				
C1a	--	Chassis		(V360460)		
* C1b	V3713700	Foot	2K25		4	
C2	--	Circuit Board Assembly	DM	(V360610)		
* C2a	V3555300	Circuit Board	DM			
C2b	--	Stay	VR	(V360550)		
C2c	--	Heat Sink	DTXPRESS	(V360560)		
C2d	EK400500	Pan Head Screw	SP 3.0X8 MFZN2Y		2	01
C2e	EK400500	Pan Head Screw	SP 3.0X8 MFZN2Y		3	01
C3	EP600230	Bind Head Tapping Screw-B	3.0X6 MFZN2BL		8	01
C4	EP600190	Bind Head Tapping Screw-B	3.0X8 MFZN2BL		2	01
C5	--	Circuit Board Assembly	JK	(V371380)		
* C5a	V3555200	Circuit Board	JK			
C5b	--	Connector Assembly	PH-PH 8P 160L	(V361010)		
C5c	--	Connector Assembly	PH-PH 5P 130L	(V361030)		
C5d	--	Connector Assembly	PH-PH 12P 120L	(V361040)		
C5e	--	Connector assembly	PH-PH 3P 120L	(V361000)		
C6	EP600230	Bind Head Tapping Screw-B	3.0X6 MFZN2BL		4	01
* C7	V3814600	Shield terminal Assembly			2	
		ACCESSORY				
	VT368600	AC Adapter	PA-3B JP	J		09
	VT368700	AC Adapter	PA-3B UC	U,C		
	VT368800	AC Adapter	PA-3B CEE	N		08

*: New parts

RANK: Japan only

FRONT PANEL UNIT



REF NO.	PART NO.	DESCRIPTION		REMARKS	QTY	RANK
		FRONT PANEL UNIT		DTXPRESS		
	--	Front Panel Unit		(V360700)		
* 1	V3605800	Front Panel Assembly				01
* 2	V3610800	Circuit Board Assembly	LCD			
* 3	V3605000	Cover	LCD			
4	EP620100	Bind Head Tapping Screw-P	2.6X8 MFZN2Y		4	01
5	--	Circuit Board Assembly	AUX	(V360590)		
* 5a	V3555500	Circuit Board	AUX			
5b	--	Stay		(V360510)	9	03
5c	EP600230	Bind Head Tapping Screw-B	3.0X6 MFZN2BL		6	03
5d	--	Connector Assembly	PH-PH 6P 80L	(V361050)		
6	EP620100	Bind Head Tapping Screw-P	2.6X8 MFZN2Y		2	
* 7	V3606000	Circuit Board Assembly	PN		5	01
* 7a	V3555400	Circuit Board	PN			
7b	VM825800	OP Button	TG100		9	
7c	VM825700	Mode Button	CBX-T3		6	
7d	--		PH-PH 16P 90L	(V361020)		
* 8	V3605200	Panel Stay				
9	EP620100	Bind Head Tapping Screw-P	2.6X8 MFZN2Y		5	

*: New parts

RANK: Japan only

ELECTRICAL PARTS

REF NO.	PART NO.	DESCRIPTION		REMARKS	QTY	RANK
		ELECTRICAL PARTS		DTXPRESS		
*	V3555300	Circuit Board	DM	(XW047A0)		
*	V3555500	Circuit Board	AUX	(XW100A0)		
*	V3555200	Circuit Board	JK	(XW100A0)		
*	V3555400	Circuit Board	PN	(XW100A0)		
*	V3555300	Circuit Board	DM	(XW047C0)		
*	V3605400	Cover				
	XT432A00	IC		ROM 8M		
	VS246400	Lithium Battery	CR2450			03
BT001	VS246300	Battery Holder	CR2450BH			03
C0001	UB245100	Monolithic Ceramic Cap.	F 0.100 25V Z			01
-0003	UB245100	Monolithic Ceramic Cap.	F 0.100 25V Z			01
C0005	UB052100	Monolithic Ceramic Cap.	SL 100P 50V J			01
C0006	UB245100	Monolithic Ceramic Cap.	F 0.100 25V Z			01
C0008	UB245100	Monolithic Ceramic Cap.	F 0.100 25V Z			01
-0011	UB245100	Monolithic Ceramic Cap.	F 0.100 25V Z			01
C0012	UR837470	Electrolytic Cap.	47.00 16.0V			01
C0013	UB245100	Monolithic Ceramic Cap.	F 0.100 25V Z			01
C0014	FP736470	Tantalum Cap.	4.70 16V M			01
C0015	UB245100	Monolithic Ceramic Cap.	F 0.100 25V Z			01
C0016	UR837100	Electrolytic Cap.	10.00 16.0V			01
C0017	UR837100	Electrolytic Cap.	10.00 16.0V			01
C0018	UB245100	Monolithic Ceramic Cap.	F 0.100 25V Z			01
C0019	UR837100	Electrolytic Cap.	10.00 16.0V			01
C0020	UB245100	Monolithic Ceramic Cap.	F 0.100 25V Z			01
-0022	UB245100	Monolithic Ceramic Cap.	F 0.100 25V Z			01
C0023	UR837100	Electrolytic Cap.	10.00 16.0V			01
C0024	UB245100	Monolithic Ceramic Cap.	F 0.100 25V Z			01
C0025	UR837470	Electrolytic Cap.	47.00 16.0V			01
-0028	UR837100	Electrolytic Cap.	10.00 16.0V			01
C0029	UB245100	Monolithic Ceramic Cap.	F 0.100 25V Z			01
C0030	UB052220	Monolithic Ceramic Cap.	SL 220P 50V J			01
C0031	UB245100	Monolithic Ceramic Cap.	F 0.100 25V Z			01
C0032	UR837100	Electrolytic Cap.	10.00 16.0V			01
C0034	UB051220	Monolithic Ceramic Cap.	SL 22P 50V J			01
C0035	UB051220	Monolithic Ceramic Cap.	SL 22P 50V J			01
C0036	UR837100	Electrolytic Cap.	10.00 16.0V			01
C0037	UB245100	Monolithic Ceramic Cap.	F 0.100 25V Z			01
C0038	UB245100	Monolithic Ceramic Cap.	F 0.100 25V Z			01
C0040	UR837100	Electrolytic Cap.	10.00 16.0V			01
C0041	UB245100	Monolithic Ceramic Cap.	F 0.100 25V Z			01
-0043	UB245100	Monolithic Ceramic Cap.	F 0.100 25V Z			01
C0044	UR837100	Electrolytic Cap.	10.00 16.0V			01
C0045	UB044100	Monolithic Ceramic Cap.	F 0.010 50V Z			01
C0046	UR837100	Electrolytic Cap.	10.00 16.0V			01
C0047	UB245100	Monolithic Ceramic Cap.	F 0.100 25V Z			01
C0048	UB044100	Monolithic Ceramic Cap.	F 0.010 50V Z			01
C0049	UB044100	Monolithic Ceramic Cap.	F 0.010 50V Z			01
C0050	UR837100	Electrolytic Cap.	10.00 16.0V			01
C0051	UB245100	Monolithic Ceramic Cap.	F 0.100 25V Z			01
C0052	UB052100	Monolithic Ceramic Cap.	SL 100P 50V J			01
C0101	UB245100	Monolithic Ceramic Cap.	F 0.100 25V Z			01
C0102	UB013100	Monolithic Ceramic Cap.	B 1000P 50V K			01
C0103	UB013100	Monolithic Ceramic Cap.	B 1000P 50V K			01
C0104	UB044100	Monolithic Ceramic Cap.	F 0.010 50V Z			01
C0105	UB044100	Monolithic Ceramic Cap.	F 0.010 50V Z			01
C0106	UB245100	Monolithic Ceramic Cap.	F 0.100 25V Z			01
C0107	UR837100	Electrolytic Cap.	10.00 16.0V			01
C0108	UB245100	Monolithic Ceramic Cap.	F 0.100 25V Z			01
-0110	UB245100	Monolithic Ceramic Cap.	F 0.100 25V Z			01
C0111	UR849100	Electrolytic Cap.	1000 25.0V			01
C0112	UB245100	Monolithic Ceramic Cap.	F 0.100 25V Z			01
C0113	UR837220	Electrolytic Cap.	22.00 16.0V			01
C0114	UR866100	Electrolytic Cap.	1.00 50.0V			01
C0115	UR866100	Electrolytic Cap.	1.00 50.0V			01
C0116	UB013680	Monolithic Ceramic Cap.	B 6800P 50V K			01
C0117	UB013680	Monolithic Ceramic Cap.	B 6800P 50V K			01
C0118	UR847100	Electrolytic Cap.	10.00 25.0V			01
C0119	UB245100	Monolithic Ceramic Cap.	F 0.100 25V Z			01

*: New parts

RANK: Japan only

REF NO.	PART NO.	DESCRIPTION	REMARKS	QTY	RANK
C0120	UB245100	Monolithic Ceramic Cap.	F 0.100 25V Z		01
C0121	UB052120	Monolithic Ceramic Cap.	SL 120P 50V J		01
C0122	UB052120	Monolithic Ceramic Cap.	SL 120P 50V J		01
C0123	UB245100	Monolithic Ceramic Cap.	F 0.100 25V Z		01
C0124	UB013680	Monolithic Ceramic Cap.	B 6800P 50V K		01
C0125	UB013680	Monolithic Ceramic Cap.	B 6800P 50V K		01
C0126	UB245100	Monolithic Ceramic Cap.	F 0.100 25V Z		01
C0127	UR838100	Electrolytic Cap.	100.00 16.0V		01
-0130	UR838100	Electrolytic Cap.	100.00 16.0V		01
C0133	UB245100	Monolithic Ceramic Cap.	F 0.100 25V Z		01
C0136	UR837100	Electrolytic Cap.	10.00 16.0V		01
C0137	UR837100	Electrolytic Cap.	10.00 16.0V		01
C0138	UB245100	Monolithic Ceramic Cap.	F 0.100 25V Z		01
-0143	UB245100	Monolithic Ceramic Cap.	F 0.100 25V Z		01
C0144	UR837100	Electrolytic Cap.	10.00 16.0V		01
-0147	UR837100	Electrolytic Cap.	10.00 16.0V		01
C0148	UB052220	Monolithic Ceramic Cap.	SL 220P 50V J		01
C0149	UB052220	Monolithic Ceramic Cap.	SL 220P 50V J		01
C0150	UR837100	Electrolytic Cap.	10.00 16.0V		01
-0153	UR837100	Electrolytic Cap.	10.00 16.0V		01
C0154	UB052220	Monolithic Ceramic Cap.	SL 220P 50V J		01
-0157	UB052220	Monolithic Ceramic Cap.	SL 220P 50V J		01
C0158	UR838100	Electrolytic Cap.	100.00 16.0V		01
C0159	UR837470	Electrolytic Cap.	47.00 16.0V		01
C0160	UR837470	Electrolytic Cap.	47.00 16.0V		01
C0161	UR837220	Electrolytic Cap.	22.00 16.0V		01
C0162	UR837220	Electrolytic Cap.	22.00 16.0V		01
C0163	UR837100	Electrolytic Cap.	10.00 16.0V		01
C0164	UR837100	Electrolytic Cap.	10.00 16.0V		01
C0165	UB245100	Monolithic Ceramic Cap.	F 0.100 25V Z		01
C0166	UB245100	Monolithic Ceramic Cap.	F 0.100 25V Z		01
C0167	UR837100	Electrolytic Cap.	10.00 16.0V		01
C0168	UB013100	Monolithic Ceramic Cap.	B 1000P 50V K		01
C0169	UB013100	Monolithic Ceramic Cap.	B 1000P 50V K		01
C0170	UB051220	Monolithic Ceramic Cap.	SL 22P 50V J		01
C0171	UB051220	Monolithic Ceramic Cap.	SL 22P 50V J		01
C0172	UR829220	Electrolytic Cap.	2200 10.0V		01
C0173	UB245100	Monolithic Ceramic Cap.	F 0.100 25V Z		01
C0701	UB245100	Monolithic Ceramic Cap.	F 0.100 25V Z		01
-0848	UB245100	Monolithic Ceramic Cap.	F 0.100 25V Z		01
CN001	VB390400	Connector Base Post	PH- 8P TE		01
CN002	VB390800	Connector Base Post	PH-12P TE		01
CN003	VF283300	Connector Base Post	PH-15P TE		01
CN004	VF283400	Connector Base Post	PH-16P TE		01
CN101	VB390100	Connector Base Post	PH- 5P TE		01
CN102	VB390200	Connector Base Post	PH- 6P TE		01
D0001	VV925900	Diode	RLS-73 TE-11		01
-0003	VV925900	Diode	RLS-73 TE-11		01
D0101	VT332900	Diode	1SS355 TE-17		01
D0102	VT532500	Diode	1SR154-400		01
-0105	VT532500	Diode	1SR154-400		01
D0106	VT332900	Diode	1SS355 TE-17		01
-0108	VT332900	Diode	1SS355 TE-17		01
* DA001	V3749000	Diode Array	DA204K 2A X2 T146		01
EM001	FZ005920	LC Filter	LS MT Y223NB		02
EM002	FZ005920	LC Filter	LS MT Y223NB		02
EM101	VR193800	LC Filter	STF-104ZB-TBM		01
-103	VR193800	LC Filter	STF-104ZB-TBM		01
IC001	XU947A00	IC	HG73C205FD	SWX00B	09
* IC003	XU164A00	IC	MSM27C3202CZ-NGS-K	RAM 32M	
* IC004	XW376100	IC	KM23C16000C	MASK ROM 16M	
IC005	XU462A00	IC	MSM514260C-60TS-K	DRAM 4M	08
IC006	XV976A00	IC	M5M51008CFP-70H-SR	SRAM	07
IC007	XP867A00	IC	UPD63200GS-E1	D/A CONVERTER	07
IC008	XR967A00	IC	MB3790PF	ASSP	05
IC009	XI348A00	IC	SC7SU04FEL	INVERTER	01
IC010	XU073A00	IC	SN75C1168NSR	LINE	05
IC011	XD838A00	IC	SN74HC245NSR	BUFFER	04
IC012	XQ042A00	IC	SN74HC374ANSR	D-FF	03
IC013	VK863100	IC Socket	DICF-42CS-E		03

*: New parts

RANK: Japan only

REF NO.	PART NO.	DESCRIPTION		REMARKS	QTY	RANK
IC014	XD599A00	IC	TC74HC32F-T1	OR		01
IC101	VR903700	Photo Coupler	HCPL-M600			04
IC102	XM968B00	IC	UPC24M09AHF	REGULATOR		03
IC103	XL497A00	IC	UPC7805AHF	REGULATOR +5V		02
IC104	XT333A00	IC	UPC29M33HF	REGULATOR +3.3V		03
IC105	XQ138A00	IC	NJM4556AMT1	SOP		03
IC106	XF291A00	IC	UPC4570G2	OP AMP		03
IC108	XQ138A00	IC	NJM4556AMT1	SOP		03
IC109	XF291A00	IC	UPC4570G2	OP AMP		03
IC110	XF291A00	IC	UPC4570G2	OP AMP		03
JK001	VM761000	DIN Connector	DIN JACK MD-S810	TO-HOST		03
JK002	LB301920	Phone Jack	HLJ4306	H.H.CONT		02
JK101	VK519000	DIN Connector	5P3 YKF51-50	MIDI IN, MIDI OUT		04
JK102	VS056300	Phone Jack	HLJ7001-01	9/10		01
JK103	VJ207400	DC-IN Jack	16V DC 3A HEC2305	DC IN 12V		01
JK104	VS056400	Phone Jack	HLJ7101-01	OUTPUT L/MONO		01
JK105	VS056400	Phone Jack	HLJ7101-01	OUTPUT R		01
JK107	VZ338600	Phone Jack	HLJ0544	PHONES		02
L0002	VL139800	Inductor	BLM31A700SPT 70ohm			01
-0004	VL139800	Inductor	BLM31A700SPT 70ohm			01
L0006	VL139800	Inductor	BLM31A700SPT 70ohm			01
-0022	VL139800	Inductor	BLM31A700SPT 70ohm			01
L0023	VS740100	Chip Inductance	BLM21B751S 2125			03
L0024	VS740100	Chip Inductance	BLM21B751S 2125			03
L0025	VL139800	Inductor	BLM31A700SPT 70ohm			01
-0029	VL139800	Inductor	BLM31A700SPT 70ohm			01
L0101	VS740100	Chip Inductance	BLM21B751S 2125ohm			03
-104	VS740100	Chip Inductance	BLM21B751S 2125ohm			03
L0105	VG238200	LC Filter	PLT2003C			04
L0106	VS740100	Chip Inductance	BLM21B751S 2125			03
-111	VS740100	Chip Inductance	BLM21B751S 2125			03
R0001	RD257100	Carbon Resistor (chip)	10.0K 0.1 J			01
R0006	RD254560	Carbon Resistor (chip)	56.0 0.1 J			01
R0007	RD254560	Carbon Resistor (chip)	56.0 0.1 J			01
R0012	RD255100	Carbon Resistor (chip)	100.0 0.1 J			01
R0013	RD255100	Carbon Resistor (chip)	100.0 0.1 J			01
R0014	RD257100	Carbon Resistor (chip)	10.0K 0.1 J			01
R0015	RD256100	Carbon Resistor (chip)	1.0K 0.1 J			01
R0016	RD257100	Carbon Resistor (chip)	10.0K 0.1 J			01
-0018	RD257100	Carbon Resistor (chip)	10.0K 0.1 J			01
R0019	RD255100	Carbon Resistor (chip)	100.0 0.1 J			01
R0024	RD255330	Carbon Resistor (chip)	330.0 0.1 J			01
R0025	RD257470	Carbon Resistor (chip)	47.0K 0.1 J			01
R0026	RD256100	Carbon Resistor (chip)	1.0K 0.1 J			01
-0029	RD256100	Carbon Resistor (chip)	1.0K 0.1 J			01
R0030	RD256270	Carbon Resistor (chip)	2.7K 0.1 J			01
R0031	RD255220	Carbon Resistor (chip)	220.0 0.1 J			01
R0032	RD154680	Carbon Resistor (chip)	68.0 1/4 J			01
R0033	RD154680	Carbon Resistor (chip)	68.0 1/4 J			01
R0042	RD257100	Carbon Resistor (chip)	10.0K 0.1 J			01
-0045	RD257100	Carbon Resistor (chip)	10.0K 0.1 J			01
R0047	RD257100	Carbon Resistor (chip)	10.0K 0.1 J			01
-0049	RD257100	Carbon Resistor (chip)	10.0K 0.1 J			01
R0050	RD255100	Carbon Resistor (chip)	100.0 0.1 J			01
R0051	RD257100	Carbon Resistor (chip)	10.0K 0.1 J			01
-0053	RD257100	Carbon Resistor (chip)	10.0K 0.1 J			01
R0055	RD257100	Carbon Resistor (chip)	10.0K 0.1 J			01
R0056	RD256150	Carbon Resistor (chip)	1.5K 0.1 J			01
R0058	RD257100	Carbon Resistor (chip)	10.0K 0.1 J			01
R0059	RD255100	Carbon Resistor (chip)	100.0 0.1 J			01
R0060	RD257100	Carbon Resistor (chip)	10.0K 0.1 J			01
R0061	RD257100	Carbon Resistor (chip)	10.0K 0.1 J			01
R0062	RD250000	Carbon Resistor (chip)	0.0 0.0 J			01
R0063	RD258100	Carbon Resistor (chip)	100.0K 0.1 J			01
R0065	RD255220	Carbon Resistor (chip)	220.0 0.1 J			01
R0066	RD255220	Carbon Resistor (chip)	220.0 0.1 J			01
R0067	RD255100	Carbon Resistor (chip)	100.0 0.1 J			01
R0068	RD255100	Carbon Resistor (chip)	100.0 0.1 J			01
R0103	RD255220	Carbon Resistor (chip)	220.0 0.1 J			01
-0105	RD255220	Carbon Resistor (chip)	220.0 0.1 J			01

*: New parts

RANK: Japan only

REF NO.	PART NO.	DESCRIPTION		REMARKS	QTY	RANK
R0106	RD256220	Carbon Resistor (chip)	2.2K 0.1 J			01
R0107	RD257100	Carbon Resistor (chip)	10.0K 0.1 J			01
-0109	RD257100	Carbon Resistor (chip)	10.0K 0.1 J			01
R0110	RD256100	Carbon Resistor (chip)	1.0K 0.1 J			01
R0111	RD257100	Carbon Resistor (chip)	10.0K 0.1 J			01
R0112	RD257100	Carbon Resistor (chip)	10.0K 0.1 J			01
R0113	RD257120	Carbon Resistor (chip)	12.0K 0.1 J			01
R0114	RD257120	Carbon Resistor (chip)	12.0K 0.1 J			01
R0115	RD257270	Carbon Resistor (chip)	27.0K 0.1 J			01
R0116	RD257270	Carbon Resistor (chip)	27.0K 0.1 J			01
R0117	RD256680	Carbon Resistor (chip)	6.8K 0.1 J			01
R0118	RD256680	Carbon Resistor (chip)	6.8K 0.1 J			01
R0122	RD256100	Carbon Resistor (chip)	1.0K 0.1 J			01
R0123	RD256100	Carbon Resistor (chip)	1.0K 0.1 J			01
R0128	RD257100	Carbon Resistor (chip)	10.0K 0.1 J			01
R0131	RD257100	Carbon Resistor (chip)	10.0K 0.1 J			01
R0132	RD256100	Carbon Resistor (chip)	1.0K 0.1 J			01
R0133	RD256100	Carbon Resistor (chip)	1.0K 0.1 J			01
R0135	RD256100	Carbon Resistor (chip)	1.0K 0.1 J			01
R0136	RD256100	Carbon Resistor (chip)	1.0K 0.1 J			01
R0137	RD256330	Carbon Resistor (chip)	3.3K 0.1 J			01
R0138	RD256100	Carbon Resistor (chip)	1.0K 0.1 J			01
R0139	RD256100	Carbon Resistor (chip)	1.0K 0.1 J			01
R0140	RD256330	Carbon Resistor (chip)	3.3K 0.1 J			01
R0141	RD255470	Carbon Resistor (chip)	470.0 0.1 J			01
R0142	RD256470	Carbon Resistor (chip)	4.7K 0.1 J			01
-0145	RD256470	Carbon Resistor (chip)	4.7K 0.1 J			01
R0146	RD256560	Carbon Resistor (chip)	5.6K 0.1 J			01
R0147	RD256560	Carbon Resistor (chip)	5.6K 0.1 J			01
R0148	RD258100	Carbon Resistor (chip)	100.0K 0.1 J			01
-0151	RD258100	Carbon Resistor (chip)	100.0K 0.1 J			01
R0152	RD255820	Carbon Resistor (chip)	820.0 0.1 J			01
R0153	RD255820	Carbon Resistor (chip)	820.0 0.1 J			01
R0154	RD256100	Carbon Resistor (chip)	1.0K 0.1 J			01
R0155	RD256100	Carbon Resistor (chip)	1.0K 0.1 J			01
R0156	RD256470	Carbon Resistor (chip)	4.7K 0.1 J			01
R0157	RD257100	Carbon Resistor (chip)	10.0K 0.1 J			01
R0158	RD257100	Carbon Resistor (chip)	10.0K 0.1 J			01
R0159	RD256470	Carbon Resistor (chip)	4.7K 0.1 J			01
R0160	HV754680	Flame Proof C. Resistor	68.0 1/4 J			01
R0161	RD257470	Carbon Resistor (chip)	47.0K 0.1 J			01
R0162	RD258100	Carbon Resistor (chip)	100.0K 0.1 J			01
R0163	RD256100	Carbon Resistor (chip)	1.0K 0.1 J			01
R0164	RD256100	Carbon Resistor (chip)	1.0K 0.1 J			01
R0165	RD154470	Carbon Resistor (chip)	47.0 1/4 J			01
R0166	RD154470	Carbon Resistor (chip)	47.0 1/4 J			01
R0167	RD257100	Carbon Resistor (chip)	10.0K 0.1 J			01
-0170	RD257100	Carbon Resistor (chip)	10.0K 0.1 J			01
R0171	RD256100	Carbon Resistor (chip)	1.0K 0.1 J			01
-0174	RD256100	Carbon Resistor (chip)	1.0K 0.1 J			01
R0179	RD258100	Carbon Resistor (chip)	100.0K 0.1 J			01
RA001	RE045100	Resistor Array	100X4			01
-004	RE045100	Resistor Array	100X4			01
RA005	RE047100	Resistor Array	10KX4			01
RA006	RE045100	Resistor Array	100X4			01
-008	RE045100	Resistor Array	100X4			01
RA009	RE047100	Resistor Array	10KX4			01
-011	RE047100	Resistor Array	10KX4			01
RA012	RE045100	Resistor Array	100X4			01
-025	RE045100	Resistor Array	100X4			01
RA026	RE047100	Resistor Array	10KX4			01
-032	RE047100	Resistor Array	10KX4			01
RA033	RE045100	Resistor Array	100X4			01
RA034	RE047100	Resistor Array	10KX4			01
RA035	RE047100	Resistor Array	10KX4			01
SW001	VN210700	Slide Switch	SSSF124-S06N-0	MIDI. PC2, PC1. Mac		03
TR101	VV556400	Transistor	2SC2412K Q,R,S			01
TR102	VV556400	Transistor	2SC2412K Q,R,S			01
TR103	VD303700	Transistor	2SC3326 A,B TE85R			01
TR104	VD303700	Transistor	2SC3326 A,B TE85R			01

*: New parts

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REF NO.	PART NO.	DESCRIPTION	REMARKS	QTY	RANK
TR105	VV556400	Transistor	2SC2412K Q,R,S		01
TR106	VJ927200	Transistor	2SA1162 O,Y		01
TR107	VD303700	Transistor	2SC3326 A,B TE85R		01
-110	VD303700	Transistor	2SC3326 A,B TE85R		01
VR002	V3059200	Rotary Variable Resistor	B 10K RK0971220	ACCOMP VOL	
VR101	V2904100	Rotary Variable Resistor	SW 10KAX2 RK09712	POWER SW, MASTER VR	
X0001	VZ703600	Quartz Crystal Unit	8.4672M SMD-49		03
ZD101	VU172600	Zener Diode	UDZS10B TE-17 10V		01
	V3555500	Circuit Board	AUX	(XW100A0)	
	V3555200	Circuit Board	JK	(XW100A0)	
	V3555400	Circuit Board	PN	(XW100A0)	
	V3605300	Terminal	GND		
C0201	UF037100	Electrolytic Cap. (chip)	10 16V		01
C0202	UB013100	Monolithic Ceramic Cap.	B 1000P 50V K		01
-0209	UB013100	Monolithic Ceramic Cap.	B 1000P 50V K		01
C0210	UF056220	Electrolytic Cap. (chip)	2.2 35V		01
C0211	UB245100	Monolithic Ceramic Cap.	F 0.100 25V Z		01
-0227	UB245100	Monolithic Ceramic Cap.	F 0.100 25V Z		01
C0228	UB052100	Monolithic Ceramic Cap.	SL 100P 50V J		01
-0237	UB052100	Monolithic Ceramic Cap.	SL 100P 50V J		01
C0238	UB245100	Monolithic Ceramic Cap.	F 0.100 25V Z		01
-0254	UB245100	Monolithic Ceramic Cap.	F 0.100 25V Z		01
C0255	UF037100	Electrolytic Cap. (chip)	10 16V		01
C0256	UB245100	Monolithic Ceramic Cap.	F 0.100 25V Z		01
-0258	UB245100	Monolithic Ceramic Cap.	F 0.100 25V Z		01
C0259	UF037100	Electrolytic Cap. (chip)	10 16V		01
C0501	UF037100	Electrolytic Cap. (chip)	10 16V		01
C0502	UF037100	Electrolytic Cap. (chip)	10 16V		01
C0503	UF066100	Electrolytic Cap. (chip)	1 50V		01
C0504	UF066100	Electrolytic Cap. (chip)	1 50V		01
C0505	UB052220	Monolithic Ceramic Cap.	SL 220P 50V J		01
C0506	UB052220	Monolithic Ceramic Cap.	SL 220P 50V J		01
C0507	UB051390	Monolithic Ceramic Cap.	SL 39P 50V J		01
C0508	UB051390	Monolithic Ceramic Cap.	SL 39P 50V J		01
C0509	UF065100	Electrolytic Cap. (chip)	0.1 50V		01
C0510	UF065100	Electrolytic Cap. (chip)	0.1 50V		01
C0511	UB051100	Monolithic Ceramic Cap.	SL 10P 50V D		01
C0512	UB051100	Monolithic Ceramic Cap.	SL 10P 50V D		01
C0513	UB245100	Monolithic Ceramic Cap.	F 0.100 25V Z		01
CN201	VB858400	Connector Base Post	PH- 5P SE		01
CN202	VB858700	Connector Base Post	PH- 8P SE		01
CN203	VC166500	Connector Base Post	PH-12P SE		01
CN204	VB858200	Connector Base Post	PH- 3P SE		01
CN401	VF283400	Connector Base Post	PH-16P TE		01
CN501	VB858500	Connector Base Post	PH- 6P SE		01
CN502	VB858200	Connector Base Post	PH- 3P SE		01
D0401	VT332900	Diode	1SS355 TE-17		01
-0403	VT332900	Diode	1SS355 TE-17		01
DA201	V3749000	Diode Array	DA204K 2A X2 T146		01
-238	V3749000	Diode Array	DA204K 2A X2 T146		01
DA239	VZ182300	Diode Array	DAP202K T146		01
-248	VZ182300	Diode Array	DAP202K T146		01
IC201	XC725A00	IC	SN74HC14NSR	INVERTER	03
IC202	XC725A00	IC	SN74HC14NSR	INVERTER	03
IC203	XR562A00	IC	NJM2902M-T1	OP AMP	02
-207	XR562A00	IC	NJM2902M-T1	OP AMP	02
IC208	XS790A00	IC	TC74HC4052AF	MPX	02
IC209	XS790A00	IC	TC74HC4052AF	MPX	02
IC501	XF291A00	IC	UPC4570G2	OP AMP	03
JK201	VS056300	Phone Jack	HLJ7001-01	KICK, SNARE, TOM1, TOM2,	01
-208	VS056300	Phone Jack	HLJ7001-01	TOM3, RIDE, CRASH, HIHAT	01
JK501	VM552100	Phone Jack	ST-Δ HSJ0912-01-01	AUX IN	02
L0201	VS740100	Chip Inductance	BLM21B751S 2125		03
-208	VS740100	Chip Inductance	BLM21B751S 2125		03
L0501	VS740100	Chip Inductance	BLM21B751S 2125		03
L0502	VS740100	Chip Inductance	BLM21B751S 2125		03
R0201	RD257120	Carbon Resistor (chip)	12.0K 0.1 J		01
R0202	RD258220	Carbon Resistor (chip)	220.0K 0.1 J		01
-0208	RD258220	Carbon Resistor (chip)	220.0K 0.1 J		01

*: New parts

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REF NO.	PART NO.	DESCRIPTION		REMARKS	QTY	RANK
R0209	RD255100	Carbon Resistor (chip)	100.0 0.1 J			01
-0216	RD255100	Carbon Resistor (chip)	100.0 0.1 J			01
R0217	RD258220	Carbon Resistor (chip)	220.0K 0.1 J			01
-0220	RD258220	Carbon Resistor (chip)	220.0K 0.1 J			01
R0221	RD257220	Carbon Resistor (chip)	22.0K 0.1 J			01
-0226	RD257220	Carbon Resistor (chip)	22.0K 0.1 J			01
R0227	RD258270	Carbon Resistor (chip)	270.0K 0.1 J			01
-0230	RD258270	Carbon Resistor (chip)	270.0K 0.1 J			01
R0231	RD256150	Carbon Resistor (chip)	1.5K 0.1 J			01
-0240	RD256150	Carbon Resistor (chip)	1.5K 0.1 J			01
R0241	RD258220	Carbon Resistor (chip)	220.0K 0.1 J			01
-0250	RD258220	Carbon Resistor (chip)	220.0K 0.1 J			01
R0251	RD256150	Carbon Resistor (chip)	1.5K 0.1 J			01
-0260	RD256150	Carbon Resistor (chip)	1.5K 0.1 J			01
R0261	RD257330	Carbon Resistor (chip)	33.0K 0.1 J			01
-0270	RD257330	Carbon Resistor (chip)	33.0K 0.1 J			01
R0271	RD258390	Carbon Resistor (chip)	390.0K 0.1 J			01
-0280	RD258390	Carbon Resistor (chip)	390.0K 0.1 J			01
R0281	RD256470	Carbon Resistor (chip)	4.7K 0.1 J			01
-0290	RD256470	Carbon Resistor (chip)	4.7K 0.1 J			01
R0291	RD258220	Carbon Resistor (chip)	220.0K 0.1 J			01
R0292	RD258220	Carbon Resistor (chip)	220.0K 0.1 J			01
R0401	RD257100	Carbon Resistor (chip)	10.0K 0.1 J			01
R0402	RD255560	Carbon Resistor (chip)	560.0 0.1 J			01
-0404	RD255560	Carbon Resistor (chip)	560.0 0.1 J			01
R0405	RD257100	Carbon Resistor (chip)	10.0K 0.1 J			01
R0406	RD255560	Carbon Resistor (chip)	560.0 0.1 J			01
-0408	RD255560	Carbon Resistor (chip)	560.0 0.1 J			01
R0409	RD257100	Carbon Resistor (chip)	10.0K 0.1 J			01
-0411	RD257100	Carbon Resistor (chip)	10.0K 0.1 J			01
R0501	RD256470	Carbon Resistor (chip)	4.7K 0.1 J			01
R0502	RD256470	Carbon Resistor (chip)	4.7K 0.1 J			01
R0503	RD257100	Carbon Resistor (chip)	10.0K 0.1 J			01
R0504	RD257100	Carbon Resistor (chip)	10.0K 0.1 J			01
R0505	RD259100	Carbon Resistor (chip)	1.0M 0.1 J			01
R0506	RD259100	Carbon Resistor (chip)	1.0M 0.1 J			01
R0507	RD257100	Carbon Resistor (chip)	10.0K 0.1 J			01
R0508	RD257100	Carbon Resistor (chip)	10.0K 0.1 J			01
R0509	RD259100	Carbon Resistor (chip)	1.0M 0.1 J			01
R0510	RD259100	Carbon Resistor (chip)	1.0M 0.1 J			01
SW201	VU710700	Slide Switch	KYP06-1	INPUT ATTENUATION		05
SW401	VK701100	Push Switch	SKHQFN GREEN	PLAY		02
SW402	VK701100	Push Switch	SKHQFN GREEN	UTILITY		02
SW403	VK701100	Push Switch	SKHQFN GREEN	CLICK		02
SW404	VK701100	Push Switch	SKHQFN GREEN	TRIGG		02
SW405	VK701100	Push Switch	SKHQFN GREEN	KIT		02
SW406	VK701100	Push Switch	SKHQFN GREEN	SONG		02
SW407	VN121700	Push Switch	SKHHPP	START/S		01
SW408	VN121700	Push Switch	SKHHPP	ENTER		01
SW409	VN121700	Push Switch	SKHHPP	SHIFT		01
SW410	VN121700	Push Switch	SKHHPP	▼ PAGE		01
SW411	VN121700	Push Switch	SKHHPP	◀		01
SW412	VN121700	Push Switch	SKHHPP	-		01
SW413	VN121700	Push Switch	SKHHPP	▲ PAGE		01
SW414	VN121700	Push Switch	SKHHPP	▶		01
SW415	VN121700	Push Switch	SKHHPP	+		01
VR501	VM778800	Rotary Variable Resistor	A 10.0K RK097122	AUX IN VR		04
* VR502	V3059200	Rotary Variable Resistor	B 10K RK0971220	CLICK VOL		
	VT368600	AC Adapter	PA-3B JP	J		09
	VT368700	AC Adapter	PA-3B UC	U, C		
	VT368800	AC Adapter	PA-3B CEE	N		08

*: New parts

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OVERALL CIRCUIT DIAGRAM

